

Low-Cost Energy-Efficient 3-D Nano-Spikes-Based Electric Cell Lysis Chips

Kashif Riaz, Siu-Fung Leung, Zhiyong Fan, *Member, IEEE*, and Yi-Kuen Lee, *Member, IEEE*

Abstract—Electric cell lysis (ECL) is a promising technique to be integrated with portable lab-on-a-chip without lysing agent due to its simplicity and fast processing. ECL is usually limited by the requirements of high power/voltage and costly fabrication. In this paper, we present low-cost 3-D nano-spikes-based ECL (NSP-ECL) chips for efficient cell lysis at low power consumption. Highly ordered HAR NSP arrays with controllable dimensions were fabricated on commercial aluminum foils through scalable and electrochemical anodization and etching. The optimized multiple pulse protocols with minimized undesirable electrochemical reactions (gas and bubble generation), common on micro parallel-plate ECL chips. Due to the scalability of fabrication process, 3-D NSPs were fabricated on small chips as well as on 4-in wafers. Phase diagram was constructed by defining critical electric field to induce cell lysis and for cell lysis saturation E_{sat} to define non-ECL and ECL regions for different pulse parameters. NSP-ECL chips have achieved excellent cell lysis efficiencies η_{lysis} (ca 100%) at low applied voltages (2 V), 2~3 orders of magnitude lower than that of conventional systems. The energy consumption of NSP-ECL chips was 0.5-2 mJ/mL, 3~9 orders of magnitude lower as compared with the other methods (5J/mL-540kJ/mL). [2016-0305]

Index Terms—Nano-spikes, electric cell lysis chips, electrochemical anodization and etching processes, electric field enhancement, energy-efficient, lab on chip.

I. INTRODUCTION

CELL LYSIS is an important step in sample preparation procedures and biopharmaceutical product extraction to release intracellular contents, i.e., DNA, RNA, hormones, vaccines, antibodies, recombinant proteins, and so forth. by disrupting cell membrane [1]–[6]. Economics of these procedures is greatly influenced by downstream processing steps, i.e., separation, purification, and so on. [1]. Sample preparation for molecular, protein and genomic diagnostic and analysis is time-consuming, labor intensive and costly process due

to multiple steps and bulky instruments [4], [6]–[8]. Lab-on-a-chip (LOC) and micro total analysis system (μ -TAS) are rapidly growing in different fields ranging from molecular/protein/genome diagnostic and analysis to the search for life on Mars [9]–[13]. Due to recent developments in micro/nanotechnologies, conventional bulky and costly sample preparation processes can be scaled down and integrated into a single compact, automated, and portable microsystem, LOC or μ -TAS [4]–[12]. These microsystems have great promise due to their simplicity, low cost, time efficiency, low consumption of valuable reagents and biological samples [4]–[12].

Numerous techniques have been employed for cell lysis on integrated microsystems, LOC, or μ -TAS such as mechanical, chemical, thermal, ultrasonic, optical, electrical, with their unique advantages and limitations [2]–[7]. Mechanical cell lysis (MCL) based on exerting localized high pressure, shear stress, friction forces, compressive stress, on cell membrane through micro-channels, filters, moving membranes, beads, etc [2]–[5]. MCL integration on LOC is limited due to moving parts and blockage of micro/nanochannels, gaps, filters by cell debris [3]–[5]. Furthermore, due to cell debris micronization into small fragments and non-selective release of products through MCL; additional costly and time-consuming separation and purification steps are required [3]–[5]. Chemical cell lysis (CCL) utilized lysis agents such as surfactants, enzymes, detergents, etc., to dissolve cell membrane in microfluidic channel network [2]–[5]. CCL methods are limited due to pretreatment of lysing agents, purification of the added agents for downstream processing, different protocols for different samples and inherently slow due to complex chemical processes [3]–[5]. Thermal cell lysis utilized high temperatures and cyclic heating for cell lysis but not suitable for portable LOC systems due to high power requirement for heat generation and irreversible protein denaturation [3]–[5]. Ultrasonic cell lysis is not suitable for LOC systems due to complex instrumentation, excessive heat generation, and inefficient power transmission to samples [2]–[5]. Intracellular product yield greatly improved by increasing the intensity of cell lysis methods mentioned above, but it also increases micronization of cell debris and additional contaminants from intracellular compartments [1]. This increases the production cost and processing time due to additional downstream processing, i.e., separation, purification, etc. [1].

Electric Cell lysis (ECL) is a physical method that has potential to overcome these limitations due to its simplicity, cost effectiveness, high efficiency, fast processing, easy miniaturization, applicability to diverse samples, and possible

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TABLE I
COMPARISON OF MICRO/NANO ELECTRIC CELL LYSIS CHIPS

Ref.	Electrode	Amplitude (V)	Duration	Efficiency (%)	Remarks
[39]	3D Au/Ti micro	~8.5	-	74	Low efficiency
[40]	Pt/Ti micro	10-40	-	<80	Bubble generation
[18]	3D Au/Cr micro	10	-	30	Low efficiency
[38]	MWCNT	40	-	~100	High voltage
[14]	Cr/Au micro	20	100 μ s	90	High voltage
[41]	Cr/Au micro	10	-	80	Low efficiency
[42]	Cr/Au micro	10	-	80	Low efficiency
[43]	ITO micro	30	-	61	Low efficiency
[44]	Cr/Au micro	5-6	5-10 min.	>95	Longer time
[45]	3D carbon micro	130	400 ms	90	High voltage
[46]	Pt/Ta micro	20	0.5-2 s	~100	High voltage
Our work	3D Nano spikes	2	12ms	100\pm0.1	Low voltage High efficiency

TABLE II
COMPARISON OF ELECTRIC CELL LYSIS ON ELECTRODES WITH AND WITHOUT NANOSTRUCTURES

Ref.	Nano-structures	Voltage requirement (V)	Without nano-structures (V)	Efficiency (%)
[38]	MWCNTs	40	85	100
[35]	CNTs	35	135	>95
[36]	CNTs	35	135	>95
[37]	CNTs	40	>90	100
[34]	Nano-gaped ITO electrodes	9	-	~90
this paper	3D Nano-spikes	2	>10	100 \pm 0.1

integration with downstream processes as no lysis agents required [2]–[6], [14]. ECL employs intense pulsed electric field to induce irreversible nanopores on cell membrane which leads to cell lysis [2], [3]. ECL has been proved effective in avoiding complete cell disruption, micronization of cell debris and contaminants from intracellular compartments by selectively lysing the cell membrane rapidly and quickly [15]. Besides these advantages, ECL methods are limited by high energy consumption (5-500 J/mL) and voltage requirement (few tens of volts) as listed in Table 1 to achieve critical electric field for cell lysis E_{CL} (kV/cm). To fulfill these requirements, special costly and bulky power generators are necessary. This is highly undesirable in portable LOC applications [3], [4], [16]. Various designs have been proposed to achieve E_{CL} at low voltages either by decreasing the distance between electrodes or focusing electric field through small constriction segments and structures in microchannels or micro-chambers [2]–[4], [17]. Most commonly used 2D planar electrodes suffer from uneven exposure of cells to an electric field, resulting in low cell lysis efficiencies η_{lysis} [3], [16]. 3D electrodes were designed to overcome this drawback which showed higher η_{lysis} (30%) as compared to 2D electrodes (8%) [18]. However, the fabrication of 3D electrodes usually involves complex, time-consuming and costly fabrication steps [19], [20].

Direct current (DC) voltage is preferred as cell membrane experienced larger transmembrane potential (TMP) without lysing the intracellular components [3], [4], [17]. However, the voltage required to achieve electric field in kV/cm range usually lead to water electrolysis which may lead to gas bubble generation, extreme pH conditions and Joule

heating [3], [21]. Alternating current (AC) voltages have been used to minimize these problems for on-chip ECL at optimized frequencies [3], [4], [21]. Depending on applied electric pulse amplitude, duration and number (usually high for ECL), AC ECL techniques also suffer from gas bubble generation, Joule heating, and pH variations [21]–[24]. These undesirable phenomena resulted in the production of unwanted electrolytic chemical compounds led to electrode degradation, effects on thermo-sensitive intracellular contents, i.e., proteins and on reaction kinetics of specific application [25]–[27]. To avoid these drawbacks, subcellular sized constriction structures were employed in a microchannel, so that maximum potential drop was across the cell membrane trapped in these structures instead of in the vicinity of the electrodes [28], [29]. The integration of these structures on portable LOC is limited by complex and costly manufacturing steps, expensive equipment for micro/nanoflow, channel blocking by cell debris and bubbles [3], [17], [25]–[27]. The average electric current between the electrodes can also be reduced by applying AC pulses with low amplitude and shorter duration. However, pulse parameters should be optimized to achieve high η_{lysis} in addition to the minimization of undesirable electrochemical reactions [21], [25], [30], [31]. Cell lysis efficiencies were always a concern in previous reports and η_{lysis} were well below 100% in most of the methods mentioned above [2], [3], [4] (Table 1).

High-aspect-ratio nano-structures (nano-tubes, nano-wires etc.) were incorporated on electrodes to locally enhance electric field intensity to cell membranes and used for cell lysis [32]–[37]. The cell lysing results on these chips indicated that required voltage reduced as compared to electrodes without nano-structures but still in the range of few tens of volts [32]–[37] (Table 2). One of the bottlenecks in the integration of nanostructures on microchips are the difficulties in handling, aligning and positioning the nanostructures at the exact desired location [46]. Furthermore, the fabrication techniques employed are complex, costly, time-consuming and non-reproducible [46]. It is highly desirable to establish simple, inexpensive, reliable and scalable fabrication techniques for fabrication of reproducible and aligned nanostructures to be used in integrated portable LOC systems and potential mass production [9], [46]–[48].

In this work, we present a low-cost 3D nano-spike based electric cell lysis chip which employed self-aligned highly

158 ordered 3D Aluminum (Al) nano-spike (NSP) arrays fabricated
 159 through electrochemical anodization and etching (EA&E)
 160 processes using anodic alumina membrane(AAM) as a tem-
 161 plate. 3D self-aligned highly ordered nano-structures were
 162 fabricated using EA&E processes recently due to their sim-
 163 plicity, low cost, reproducibility, and scalability [49]. These
 164 nano-structures showed enhanced performance in the field of
 165 electronics, optoelectronic, photovoltaic, magnetism, medical,
 166 and biology [49], [51]–[54]. Alumina is already recognized
 167 as bio-compatible material and used in hip arthroplasty [55],
 168 tissue engineering especially for skin replacement [56], bone
 169 implant [57], and cell culture and proliferation [58].

170 We developed an energy-efficient 3D nano-spikes based
 171 electric cell lysis (NSP-ECL) chips for efficient cell lysis
 172 at low energy consumption. NSP-ECL chips comprised of
 173 highly-ordered high-aspect-ratio (λ) 3D Al NSP arrays with
 174 controllable dimensions, i.e., length, L_{ns} , base radius, R_{ns} ,
 175 and pitch, P_{ns} (spike to spike distance). These optimized
 176 aspect-ratio λ ($= L_{ns}/R_{ns}$) NSPs were fabricated on low-cost
 177 commercial Al foils through simple, scalable, reproducible
 178 and cost effective EA&E process. The electric field has been
 179 localized at NSPs due to high λ with an enhancement factor
 180 α . NSP-ECL chips have achieved high cell lysis efficiencies
 181 η_{lysis} (100%) at more than ten times reduced pulse ampli-
 182 tudes (2 V) through localized electric field E_{NSP} as compared
 183 to micron-distant parallel plate electric cell lysis (μ PPECL)
 184 chips without NSPs. The employment of low-cost EA&E
 185 fabrication process, optimized AC electric pulses with low
 186 amplitudes (2 V), short durations (few milliseconds) and low
 187 energy consumption (0.5-2 mJ/mL) minimized undesirable
 188 electrochemical reactions, such as gas and bubble generation
 189 on NSP-ECL chips. Due to the scalability of the fabrication
 190 process, 3D NSPs were fabricated on small chips as well as
 191 on wafers.

192 II. NANO-SPIKES BASED ELECTRIC CELL LYSIS SYSTEM

193 Schematic diagram of a nano-spikes based electric cell
 194 lysis (NSP-ECL) system along with optical micrograph
 195 of fabricated nano-spikes on an Al foil and packaged
 196 NSP-ECL chip is shown Fig. 1. NSP-ECL chips consist
 197 of 3D periodic NSP arrays fabricated on a low-cost commer-
 198 cial Al foil using nano-imprint lithography, electrochemical
 199 processes, i.e., anodization and etching and MEMS technol-
 200 ogy. By controlling dimensions of NSPs, NSPs were fabri-
 201 cated with different aspect ratios λ ($= L_{ns}/R_{ns}$). Large
 202 λ resulted in electric field enhancement E_{ns} at NSPs and
 203 applied electric field E_a was enhanced with an enhancement
 204 factor α . A PCI 6110 DAQ card (National Instrument, TX,
 205 USA) and a Labview program were used to apply AC electric
 206 pulses with adjustable pulse amplitudes V_a , durations t_p and
 207 number P_n to NSP-ECL chips. An Olympus IX70 inverted
 208 fluorescent microscope, and a QImaging Retiga 1300C digital
 209 CCD camera (Burnaby, B.C., Canada) were used to acquire
 210 a set of bright field and fluorescent micrographs before and
 211 after ECL through an image capture card. Cell lysis efficiency
 212 η_{lysis} were determined as functions of electric pulse param-
 213 eters (V_a , t_p and P_n) and NSPs dimensions using these acquired
 214 images through image processing. Due to E_{ns} and optimized

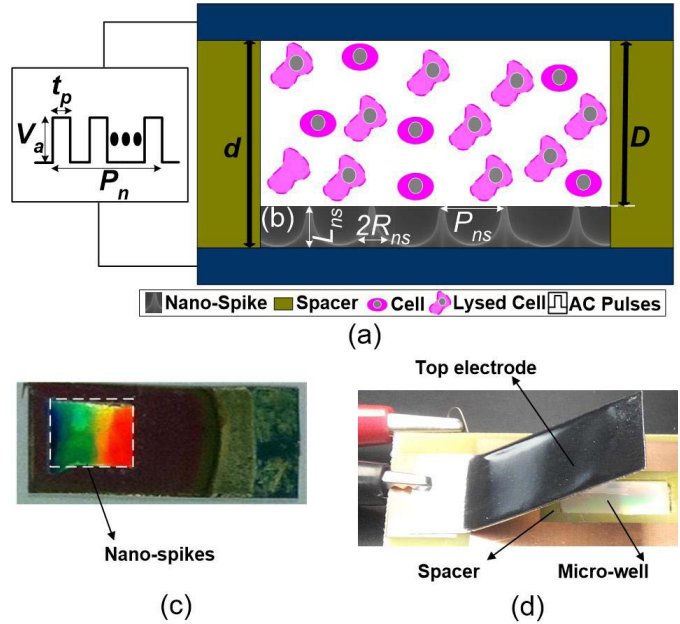


Fig. 1. Illustration of a Nano-Spikes Electric Cell Lysis (NSP-ECL) device, (a) the schematic diagram of an NSP-ECL chip with NSP arrays, (b) SEM micrograph of an array of nano-spikes, (c) optical micrograph of an Al foil with fabricated nano-spikes, and (d) optical micrograph of packaged NSP-ECL chip.

electric pulse parameters, NSP-ECL chips offer the advantage
 of achieving high η_{lysis} at reduced pulse amplitudes and
 shorter pulse durations. ECL with low pulse amplitudes and
 shorter pulse durations minimized undesirable electrochemical
 reactions such as gas and bubble generation and avoided com-
 plete disruption and micronization of cell membrane which is
 desirable in downstream process integration on LOC system.

A. Nano-Spikes Based Electric Cell Lysis Chip Design

3D periodic NSP arrays on a microchip were fabricated
 through electrochemical anodization and etching processes. 3D
 NSPs were fabricated with different controllable dimensions,
 such as length, L_{ns} , base radius, R_{ns} , and pitch, P_{ns} (spike to
 spike distance). The top and bottom electrodes are insulated
 by a spacer (3M Orange Polyimide electrical insulation tape)
 with a thickness d ($= 100\mu\text{m}$). The distance between the tip
 of the NSPs and the counter electrode of the NSP-ECL chip
 is defined as D ($= d - L_{ns}$). This spacer not only insulated
 two electrodes, but also formed a micro-well between two
 electrodes for cell sample and molecules injection (Fig. 1(a)).
 The incorporation of optimized aspect-ratio λ NSPs resulted
 in enhancement of applied electric field. The electric field
 at NSPs E_{ns} was enhanced by enhancement factor α which
 depends on the aspect ratio of NSPs. The top electrode of
 NSP-ECL chip is removable, and cell lysate can be collected
 from micro-well after electric cell lysis using a pipette.

B. 3D Nano-Spikes Fabrication Process

Major steps involved in the fabrication of NSP-ECL
 chips were nano-imprinting and scalable electrochemical
 anodization and etching processes [31], [51]–[54], [59]. First
 of all, low-cost commercially available *ca* 250 μm thick

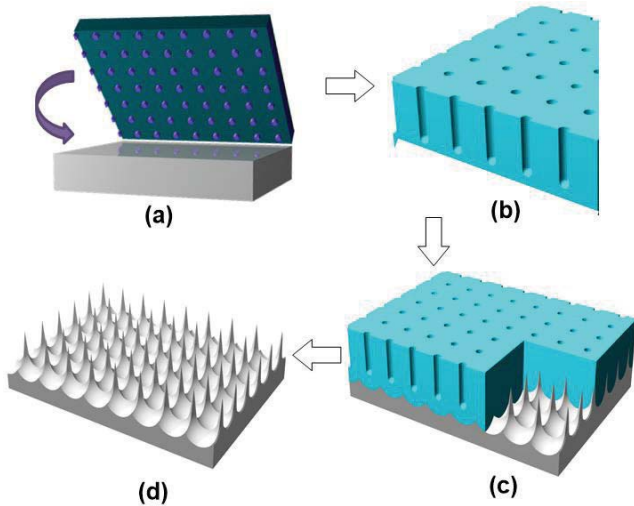


Fig. 2. Key fabrication processes of low-cost highly-ordered 3D nano-spike arrays using electrochemical anodization and etching processes, (a) Al foil was imprinted by a silicon mold with square patterned pillars, (b) imprinted Al foil with periodic nanoholes, (c) imprinted substrate was anodized and then etched to fabricate 3D nano-spike arrays, and (d) 3D high aspect-ratio nano-spike arrays fabricated through electrochemical anodization and etching processes.

Al foils (99.99% Alfa Aesar, MA, USA) were cut into pieces of $2 \times 1 \text{ cm}^2$. These Al substrates were cleaned with acetone and then rinsed with isopropyl alcohol and deionized (DI) water. These cleaned substrates were electrochemically polished for 4 minutes at 5°C in a 1:3 (v:v) mixture of perchloric acid and ethanol. A silicon stamp with square patterned pillars with a height of $\sim 200 \text{ nm}$, the diameter of $\sim 200\text{-}500 \text{ nm}$ and pitch of $1.2 \mu\text{m}$ was used for nano-imprinting (Fig. 2(a)). The electropolished substrates were imprinted by the stamp and substrates had perfect square ordered nano-indentation which defined the location of the anodic alumina membrane (AAM) pores (Fig. 2(b)). The imprinted substrates were then anodized in a home-built anodization setup using carbon rod as counter electrode using DC voltage of 600 V. The composition of electrolyte used for anodization was 1:1 (v:v) 2wt% Citric acid: Ethylene Glycol + 9 mL 0.1wt% Phosphoric acid. NSPs with different aspect ratios were fabricated by controlling anodization conditions, i.e., anodization time varies between 30–360 minutes at 10°C . Stability of electrolyte was improved by mixing citric acid with ethylene glycol, and the anodization voltage was increased up to 600 V [51]–[54]. The mixture of phosphoric acid (6%) and chromic acid (1.5%) was used to etch the anodized AAM layer at 100°C for 25 minutes to obtain perfectly ordered 3D NSP arrays (Fig. 2(c)). After etching, the 3D Al NSP electrodes were rinsed with DI water and blown dry with compressed air.

C. Scalability of Nano-Spikes Fabrication Process

The dimensions of NSPs were precisely controlled by controlling the parameters and conditions of EA&E process, i.e., the thickness of AAM, anodization time, etc. NSPs with different lengths L_{ns} ranging from 350–1100 nm was fabricated by increasing anodization time from 30–360 minutes. The maximum achievable L_{ns} was about $\sim 1100 \text{ nm}$ after

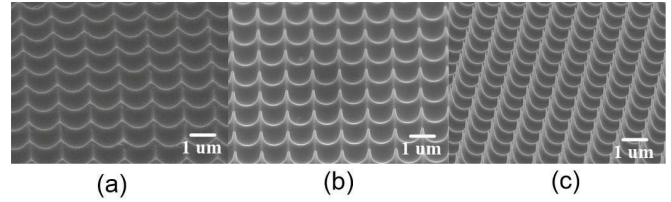


Fig. 3. SEM micrograph of 3D nano-spike arrays with different lengths L_{ns} of (a) 350 nm, (b) 750 nm, and (c) 1100 nm.

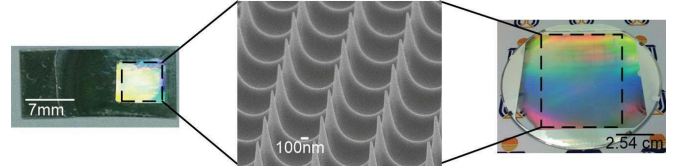


Fig. 4. Highly-ordered 3D nano-spike arrays fabricated on low-cost commercial Aluminum foil with an area of 7mm^2 and also on a 4-inch glass wafer.

anodization of 360 minutes. SEM images of NSP array electrodes with L_{ns} of 350, 750, and 1100 nm with pitch P_{ns} of $1.2 \mu\text{m}$ are shown in Fig. 3. Several advantages are associated with NSPs fabricated using EA&E processes such as periodicity, self-organization, scalability, reproducibility, and high-aspect-ratio λ . Due to the scalability of above mentioned EA&E fabrication process, it was possible to fabricate NSPs on low-cost Al foils for microchips as well as on 4-inch glass wafers (Fig. 4). The sample in microliter range was processed on 3D NSP-ECL chips, while throughput can be scaled up to handle large cell populations ($10^4 - 10^5$) on NSP-ECL wafers. This simple, low-cost, scalable, reproducible and reliable process is highly attractive for low energy and cost-effective portable μ -TAS, LOC and smartphone-based systems as well as for high throughput and large population applications.

III. MATERIAL AND METHODS

A. Cell Line Preparations

Human cervical cancer (HeLa) cell line was used in the ECL experiments to characterize cell lysis efficiencies η_{lysis} on NSP-ECL chips. HeLa cells were cultured and grown in Eagle's minimal essential medium (EMEM) (CCL-2TM, ATCC, VA, USA), supplemented with 10% fetal bovine serum (FBS) (ATCC, VA, USA) and 1% Streptomycin/Penicillin (GIBCO®, Invitrogen Inc., USA) at 37°C and 5% CO_2 . To perform the ECL experiments on the NSP-ECL chips, HeLa cells were re-suspended in the Phosphate buffered saline (PBS). Then, the EMEM medium was sucked, washed twice with PBS and trypsinized by 0.25% trypsin/EDTA (GIBCO®, Invitrogen Inc., USA) for 3–5 minutes at 37°C . The detached cells were centrifuged at 1,200 rpm at room temperature for 3 minutes. The concentration of HeLa cells was adjusted to 1×10^5 cells/mL in suspension.

B. Dual Acridine Orange/Ethidium Bromide Fluorescent Staining

Cell lysis efficiencies η_{lysis} is defined as the percentage of dead cells after application of a lysing electric field [44].

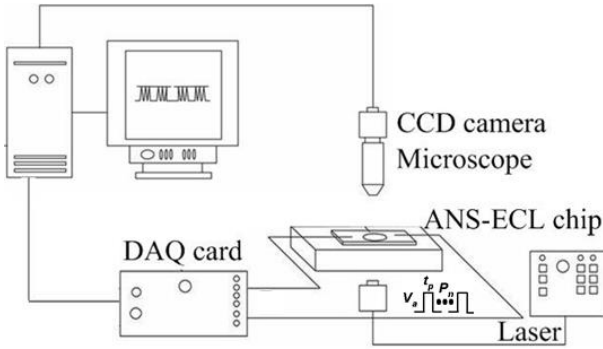


Fig. 5. The schematics of the experimental setup to perform the electric cell lysing on the fabricated NSP-ECL chips.

η_{lysis} can be determined by using dual fluorescent dye staining using Acridine Orange and Ethidium Bromide (AO/EB; Sigma, St Louis, MO, USA) which are nuclear staining dyes [60]–[62]. Acridine Orange (AO) is a membrane permeable dye and emits green fluorescence while Ethidium Bromide (EB) is membrane-impermeable dye and emits red fluorescence after entering the cell through compromised membranes. Upon staining cells with dual AO/EB dyes, live cells emit green fluorescence while lysed cells with damaged membrane emit orange-yellow fluorescence [60]–[62]. To determine η_{lysis} , the cell suspension was injected to the NSP-ECL chips and the electric pulses were applied. False readings from the reversibly electroporated cells were avoided by adding dual AO/EB staining solution to the cell suspension 5 minutes after the application of electric pulses on the NSP-ECL chips. Lysed cells exhibited orange-yellow fluorescence when EB dye bind with DNA/RNA either inside or outside the cell through the ruptured cell membrane. η_{lysis} was calculated by counting cells that appeared orange-yellow under fluorescence over the entire cells.

C. Experimental Setup

A PCI 6110 DAQ card (National Instrument, TX, USA) and a Labview program were used to apply electric pulses with adjustable pulse amplitude (V_a), pulse duration (t_p) and pulse number (P_n) to the NSP-ECL chip as shown in Fig. 5. The cell's response before and after ECL was observed using an Olympus IX70 inverted fluorescent microscope and a QImaging Retiga 1300C digital CCD camera (Burnaby, B.C., Canada) (Fig. 5). Sets of bright field and fluorescence micrographs were acquired by an image capture card. These digital images were processed to determine the η_{lysis} as a function of electric pulse parameters on NSP-ECL chips.

D. Statistical Analysis

At least 100 cells were analyzed to obtain each data point, and each experiment was repeated at least three times. The standard deviation between repeated experiments was shown as error bars.

IV. ELECTRIC FIELD ENHANCEMENT

Electric field distribution was simulated to evaluate the electric field enhancement at NSPs. A commercial finite

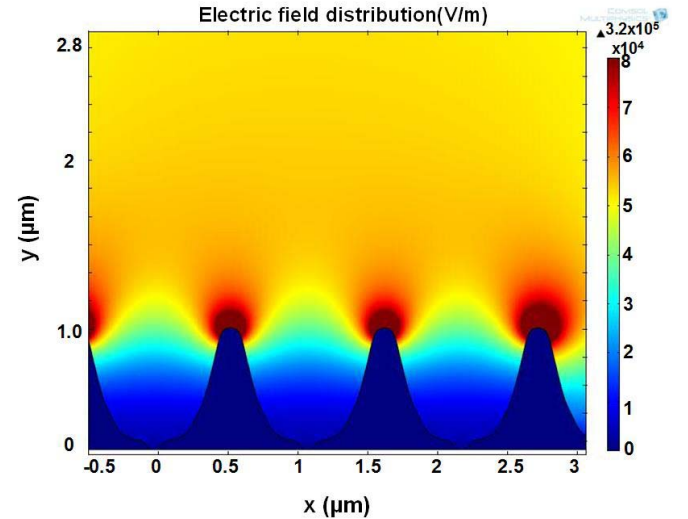


Fig. 6. Numerical simulation of the electric field distribution between nano-spoke array electrodes using COMSOL at $V_a = 4V$. The simulation shows local electric field enhancement, especially near the nano-spikes.

element method (FEM) package (COMSOL Multiphysics 4.2, COMSOL Ltd., USA) was used for electric field distribution simulations [63]. The profile of NSPs was extracted with the help of extract profiles tool using the AFM images of NSPs. The extracted coordinates of NSPs were then exported to COMSOL. The cell lysis chamber is *ca* 100 μm high (the distance between the top and bottom electrode). The top electrode and the tip of the spikes on the bottom electrode were separated by a distance D (99 μm) and the space between the two electrodes was considered as cell suspension medium (Fig. 6). The relative permittivity and conductivity of cell suspension medium were assumed to be $77.4 \pm 5\%$ and $1.7 S/m \pm 10\%$, respectively [59]. The fixed potential between the electrodes was used as the boundary condition. The fixed potential between the electrodes was applied by selecting 2D stationary electrostatics physics in COMSOL. These simulations demonstrated that applied electric field E_a is enhanced and defined by enhancement factor α which on the other hand highly depend on the aspect ratio λ of NSPs. The enhanced electric field E_{ns} is very large near tips of NSPs and E_{ns} become uniform few nm above 3D NSP arrays as shown in Fig. 6.

The enhanced electric field E_{ns} was localized on NSPs due to the optimized aspect ratio λ of NSPs. The enhancement factor α by which the applied electric field E_a is enhanced can be estimated using the following relation [64], [65]:

$$E_{ns} = E_a \times \alpha \times \gamma \quad (1)$$

where E_a is the applied electric field (V_a/D), α is the enhancement factor and γ is the correction factor to incorporate the electrochemical impedance near the fluid-electrode interface and determined through electrochemical impedance spectroscopy [66], [67]. Based on the geometries of nanostructures, several models have been proposed to estimate α [65]. In our case, the α was estimated by considering NSP as a hemi-ellipsoid with length L_{ns} and base radius R_{ns} as

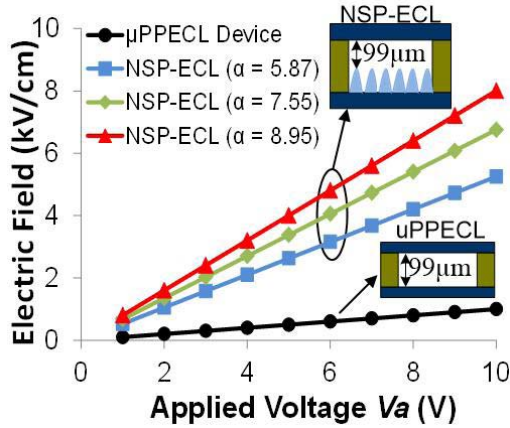


Fig. 7. Electric field as a function of applied voltages V_a for micro parallel plate electric cell lysing (μ PPECL) device without nano-spikes and NSP-ECL devices with different α .

follows [65]:

$$\alpha = \xi^3 / [\{\lambda \ln(\lambda + \xi)\} - \xi] \quad (2)$$

where $\xi = (\lambda^2 - 1)^{1/2}$ and λ is the aspect ratio of NSP (L_{ns}/R_{ns}). It is evident from (2) that α is a function of λ and α can increase exponentially with increasing λ . As mentioned previously, the aspect ratio λ can be controlled by controlling dimensions of NSPs. We have successfully fabricated NSPs with λ up to 3 using EA&E process. For NSPs with L_{ns} of 1100nm, the R_{ns} was 375nm which leads to the aspect ratio of around 3. For NSPs with λ ranging between 2 and 3, α was estimated between 5.9 and 8.9 using Equation (2). For micron-distant parallel plate electric cell lysing (μ PPECL) devices without NSPs, the electric field E_{planar} can be estimated as the ratio of applied voltage V_a to the distance between parallel plate electrodes D ($E_{planar} = V_a/D$). Interelectrode distance D of $\sim 99 \mu\text{m}$ was considered for both μ PPECL and NSP-ECL devices to compare electric field. Enhanced electric field at NSPs E_{ns} was determined using (1) and (2). The electric field was enhanced at NSP-ECL devices by enhancement factor α as compare to μ PPECL devices (Fig. 7). This means that lower voltages are required to achieve a specific electric field on the NSP-ECL devices depending on α as compared to μ PPECL devices. For example, electric field of 2 kV/cm can be achieved at 20 V for μ PPECL device, at ~ 4 V for NSP-ECL device with α of 5.87, at ~ 3 V for NSP-ECL device with α of 7.55 and at ~ 2.6 V for the NSP-ECL device with α of 8.95 (Fig. 7).

V. RESULTS AND DISCUSSION

When a cell is exposed to an externally applied electric field, localized transient microstructural changes and nanopore generation takes place in the cell membrane. These changes and induced nano-pores can either reseal (reversible electroporation) or non-reseal (irreversible electroporation) depending on applied electric pulse parameters V_a , t_p and P_n [34]–[37]. Irreversible electroporation causes rupturing of the cell membrane and cell lysis due to dielectric breakdown of the cell membrane as cell unable to maintain essential

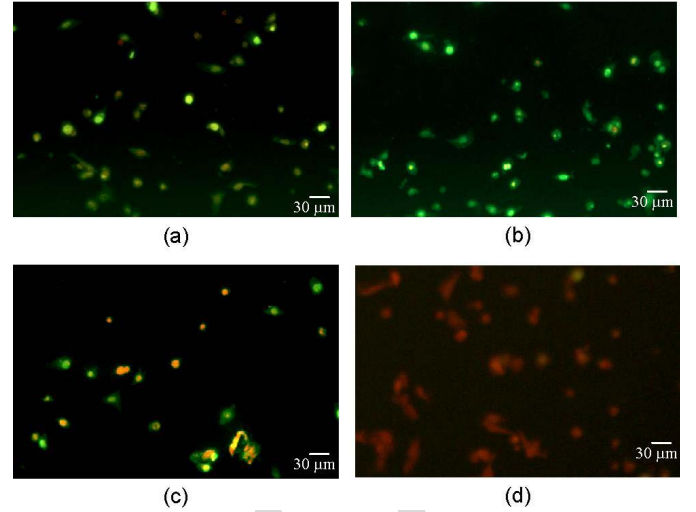


Fig. 8. Fluorescence micrographs of Acridine orange and Ethidium bromide dual stained HeLa cells treated on NSP-ECL chips and μ PPECL devices. Viable cells exhibit green fluorescence while lysed cells exhibit orange-red fluorescence due to loss of membrane integrity. (a) HeLa cells undergone electric cell lysis (ECL) on μ PPECL without nano-spikes at pulse amplitude $V_a = 5\text{V}$ and pulse duration $t_p = 12\text{ms}$, (b) HeLa cells before ECL on NSP-ECL chips ($\alpha = 8.9$), (c) HeLa cells after ECL on NSP-ECL chips ($\alpha = 8.9$) at $V_a = 2\text{V}$ and $t_p = 10\text{ms}$, and (d) HeLa cells after ECL on NSP-ECL chips ($\alpha = 8.9$) at $V_a = 2\text{V}$ and $t_p = 12\text{ms}$.

ionic balance across the membrane. ECL occurs only when applied electric pulse parameters V_a , t_p and P_n are well above their critical values [4]. Irreversible nano-pore generation is initiated when an electric field is well above its critical value E_{CL} which in turn determined by pulse amplitude V_a and density and duration of these nanopores depend on t_p and P_n [34]–[37]. It is critical to optimize these electric pulse parameters to achieve high η_{lysis} at low energy consumption to avoid undesirable electrochemical reactions and possible integration with portable devices. In our ECL experiments, we have applied rectangular AC pulses with adjustable V_a of 1–10 V, t_p of 1–12 ms and P_n of 1-10 on NSP-ECL chips with α of 5.87, 7.55 and 8.95.

A. Fluorescence Microscopy

Cell lysis efficiencies were quantified by using dual AO/EB fluorescent staining (Fig. 8). Fluorescence micrographs of cells before ECL on NSP-ECL chips showed no yellow-orange fluorescence as cell membrane was intact and impermeable to EB dye molecules (Fig. 8(b)). After ECL, cell membrane ruptured due to induction of irreversible nanopores on cell membranes by applied electric field. EB molecules entered the cells through compromised membrane and stained the lysed cells. Lysed cells exhibited orange-red fluorescence, while the live cells emitted green fluorescence (Fig. 8(c) & (d)). Almost all cells exhibited orange-red fluorescence when lysed on NSP-ECL chips at 2 V and 12 ms pulses showing high η_{lysis} . Fluorescence micrograph of ECL on μ PPECL devices at 5 V and 12 ms pulses showed almost no orange-red fluorescence showing very low η_{lysis} (Fig. 8(a)).

B. Enhancement Factor Effect on Electric Cell Lysis

Cell lysis efficiencies were quantified on NSP-ECL chips with different α and on μ PPECL devices in order to determine

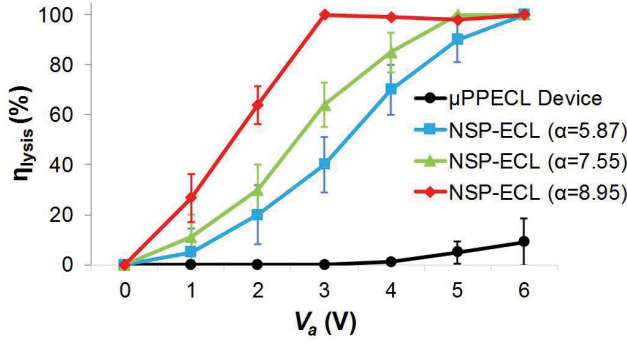


Fig. 9. Cell lysis efficiency η_{lysis} as a function of applied pulse amplitude V_a on NSP-ECL chips with different α (5.9, 7.5, 8.9) and the cell lysis efficiency of the μ PPECL device for pulse duration t_p of 10ms.

459 the effect of α on η_{lysis} as compared to μ PPECL devices
 460 without NSPs. From Fig. 9, it is clear that cell lysis on
 461 NSP-ECL chips showed higher η_{lysis} as compared to cell lysis
 462 on μ PPECL devices at specific V_a due to enhanced electric
 463 field E_{ns} on NSPs. At $V_a = 3$ V, the η_{lysis} was 40 to 100%
 464 high on NSP-ECL chips as compared to μ PPECL devices
 465 depending on enhancement factor α of NSP-ECL chips.
 466 η_{lysis} was increased with increasing α on NSP-ECL chips at
 467 specific V_a . η_{lysis} of 40%, 64% and 100% were achieved at
 468 $V_a = 3$ V on NSP-ECL chips with α of 5.87, 7.55 and 8.95
 469 respectively. NSP-ECL chips with α of 8.95 was selected for
 470 further analysis due to high η_{lysis} at low voltages.

471 C. Critical Values for Electric Cell Lysis

472 Based on the applied electric field, ECL process can be
 473 divided into three phases as shown in Fig. 10. When the
 474 applied electric field is below critical electric field E_{CL} , η_{lysis}
 475 is very low as the electric field is not sufficient to induce
 476 enough irreversible nano-pores rather reversible nanopores on
 477 the cell membrane. When the applied electric field was above
 478 E_{CL} , the electric field was strong enough to break down the
 479 integrity of cell membrane by inducing enough irreversible
 480 nano-pores. EB fluorescent molecules bound to DNA/RNA
 481 inside or outside the ruptured cell membrane and lysed cells
 482 exhibited orange-red fluorescence (Fig. 8(c) and (d)). At this
 483 stage, a small increase in pulse amplitude V_a , more and more
 484 cells lysed and η_{lysis} increased quickly (Fig. 10). η_{lysis} keep on
 485 increasing by increasing electric field until η_{lysis} saturated and
 486 electric field at this point defined as saturation electric field
 487 E_{sat} (Fig. 10). Further increase in V_a did not improve η_{lysis}
 488 but increased power consumption.

489 D. Electric Pulse Parameters Effects on Electric Cell Lysis

490 The cell lysis efficiencies were greatly influenced by applied
 491 electric pulse parameters such as V_a , t_p and P_n . Higher η_{lysis}
 492 can be achieved at higher pulse amplitude V_a , longer pulse
 493 duration t_p and higher pulse number P_n (Fig. 10). Higher pulse
 494 amplitude V_a and longer pulse duration t_p increased power
 495 requirement and may also induce undesirable electrochemical
 496 reactions. Electric pulse parameters should be optimized to
 497 achieve high η_{lysis} but at lower V_a and shorter t_p to minimize

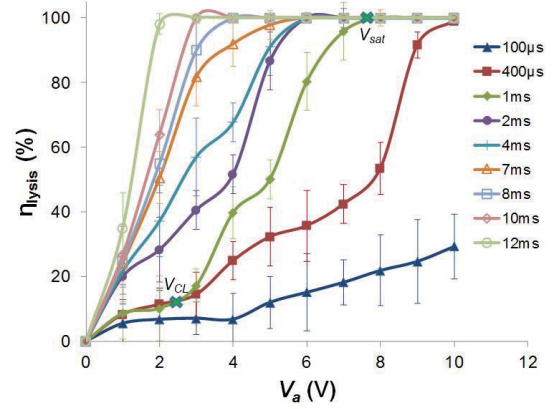


Fig. 10. Cell lysis efficiency η_{lysis} as a function of V_a and t_p for P_n of 10 on NSP-ECL chip.

498 electrochemical reactions and power requirement. We have
 499 reached high η_{lysis} ($\sim 100\%$) at V_a of 2 V, t_p of 12 ms and
 500 P_n of 10 on NSP-ECL chip (Fig. 10). This reduction in
 501 V_a is more than ten times lower as compared to μ PPECL
 502 devices.

503 E. Energy Requirement for Electric Cell Lysis

504 The energy consumption for electric cell lysis is a crucial
 505 issue especially in LOC, μ -TAS and smartphone based
 506 microsystems where limited energy is available [3], [68]. This
 507 energy requirement is high enough to employ complex, bulky
 508 and costly power generators and equipment [16], [69]. Due to
 509 high energy requirement, ECL systems usually undergo metal
 510 ion dissolution, local pH variation, Joule heating, gas and
 511 bubble generation and sample contamination [3], [4], [5], [17],
 512 [25], [68], [70]. In order to avoid these undesirable reactions
 513 on ECL devices and to integrate them on LOC, μ -TAS
 514 and smartphone based microsystems; low energy consumption
 515 ECL systems are highly desirable. In our approach, we utilized
 516 3D nano-spikes on which electric field was enhanced due to
 517 their optimized aspect-ratio. We were able to achieve cell lysis
 518 at lower pulse amplitudes due to electric field enhancement.
 519 The specific energy input W delivered to samples on NSP-
 520 ECL chips was calculated using relation:

$$521 \quad W = V_a I P_n t_p / vol \quad (3)$$

522 where V_a is the applied pulse amplitude, I is the electric
 523 current, P_n is the pulse number, t_p is the pulse duration, and
 524 vol is the sample volume (0.25 mL). A high-precision 1k Ω
 525 resistor was connected in series with the chip and serve as
 526 the current-to-voltage converter. The resistance of the resistor
 527 is too small as compared to the chip. Therefore, it can
 528 be ignored in the electric current calculation. The voltage
 529 signals from this resistor were measured by using a PCI 6110
 530 DAQ card (National Instrument, TX, USA) and a Labview
 531 program and used in the electric current calculation. The
 532 specific energy input W required to achieve optimized electric
 533 pulse protocol (2V \times 12ms for 10 pulses) was 0.5 mJ/mL
 534 (Fig. 11). The energy consumption for cell lysis on NSP-ECL

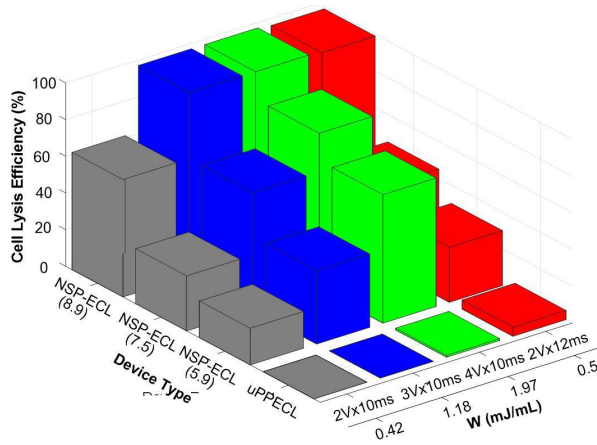


Fig. 11. η_{lysis} for different NSP-ECL and μ PPECL devices as a function of different electric pulse protocols and specific energy input W (mJ/mL).

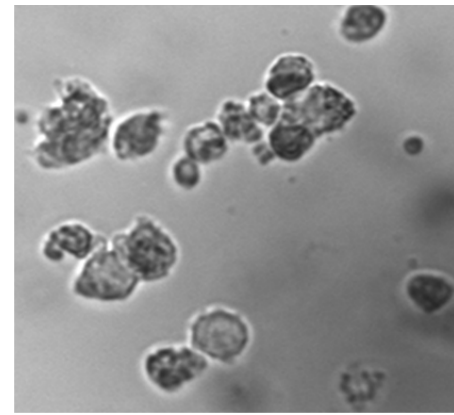
TABLE III
SPECIFIC ENERGY REQUIREMENT FOR CELL
LYSIS USING DIFFERENT METHODS

Ref.	Methods	Device characteristics	Treatment time	Specific energy input
[72]	Laser	Beam dia. of 100 μ m	60sec \times 10 times	16kJ/mL
[72]	Microwave	1025W 2.45GHz	20min.	74.6kJ/mL
[72]	Mechanical solid shear	Blade dia. 40mm 120W, 3000 rpm	6min.	540kJ/mL
[72]	Thermal lysis	90 $^{\circ}$ C	20min.	20.1 kJ/mL
[72]	Liquid shear ultrasonication	40W ultrasonic bath	20min.	132 kJ/mL
[73]	High voltage pulsed electric field	$L \times W = 30 \times 3 \text{mm}^2$ $d = 10 \text{mm}$	1 μ s	100-200 J/mL
[74]	Electroporation	$A = 0.78 \text{cm}^2$ $d = 0.3 \text{cm}$	μ s-ms	16-150 J/mL
[75]		$L \times W: 2.8 \times 0.6 \text{cm}^2$ $d = 1 \text{mm}$	100 μ s \times 32	5-533 J/mL
This paper	NSP-ECL device	NSP dimensions $L: 350-1100 \text{nm}$ $D: 200-500 \text{nm}$	12ms \times 10	0.05-3 mJ/mL

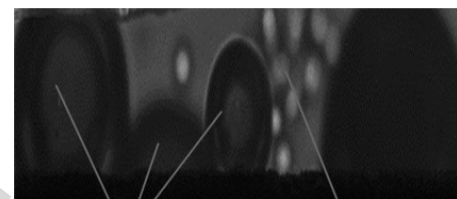
$L \times W$: electrode length \times width, d : interelectrode distance, A : electrode area, D : diameter

chips was 0.5-2 mJ/mL that is 3-9 orders of magnitude lower as compared to other cell disintegration methods as shown in Table 3.

Low device reliability and failure were observed in macro and micro ECL devices due to high voltage operations which resulted in electrolysis, gas bubble generation, Joule heating, local pH variations, etc. [21]–[27]. Electrode degradation and cell damage were observed during electroporation and ECL processes due to gas bubbles generation which resulted in local pH variations and violent hydrodynamic forces [21]–[24], [59]. Gas bubble generation was observed on micro devices due to high voltage operation especially above 6 V [22], [75] as shown in Fig. 12(b). Although AC pulses were applied on micro devices which were known to minimize electrochemical reactions, still applied pulse amplitudes were high



(a)



(b)

Fig. 12. Cell morphologies after electric cell lysis on (a) NSP-ECL chips, bubble generation, and cell micronization was avoided and (b) on a micro ECL chip, Bubble generation was observed on micro devices [22], [75].

enough to induce gas bubble generation and electrode degradation (Fig. 12 (b)). On the other hand, on NSP-ECL chips, due to the employment of NSPs, high η_{lysis} was achieved at low pulse amplitudes without bubble generation (Fig. 12(a)). In addition, the cell membrane was not fully disintegrated after ECL on NSP-ECL chips (Fig. 12(a)). This will avoid micronization of cell debris and complex, costly and time-consuming downstream processes.

F. Phase Diagram for Electric Cell Lysis

ECL occurs successfully when applied electric field is well above its critical value E_{CL} . It is crucial to determine electric pulse parameters to achieve E_{CL} as if the electric field is below this critical value; cells will be reversibly electroporated instead of lysed. E_{CL} was achieved at different V_a for different t_p , at lower V_a for longer t_p , and at higher V_a for shorter t_p . E_{CL} is defined as a critical electric field for cell lysis which induces irreversible nanopores on the cell membrane and η_{lysis} increases quickly. We have also determined electric pulse parameters to achieve saturation electric field E_{sat} at which η_{lysis} saturated. It is vital to determine E_{sat} as increasing pulse parameters after this point will only result in additional power hence energy consumption and micronization of cell debris which is not suitable for portable LOC systems and downstream processes. Using these parameters for E_{CL} and E_{sat} , we have constructed “phase diagram” for ECL of HeLa cells on NSP-ECL chips (Fig. 13). Phase diagram defines

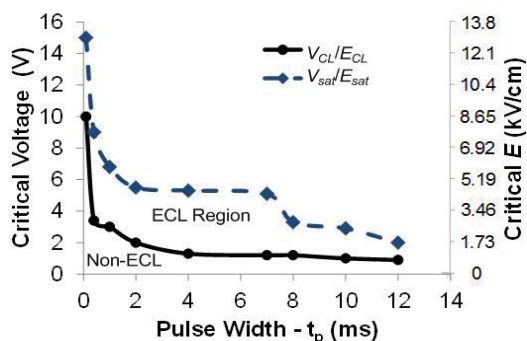


Fig. 13. The Phase diagram for the electric cell lysis of HeLa cells on the NSP-ECL chip ($\alpha = 8.9$). The Phase diagram shows the non-ECL and ECL regions for different applied pulse durations.

576 the boundary for non-ECL and ECL regions for different
 577 electric pulse parameters. Minimum pulse amplitude $V_{CL,min}$
 578 to achieve E_{CL} was 0.9 V for t_p of 12 ms which is more
 579 than thirteen times lower as compared to μ PPECL devices.
 580 Minimum pulse amplitude $V_{sat,min}$ to achieve E_{sat} was 2 V for
 581 t_p of 12 ms which is more than ten times lower as compared
 582 to μ PPECL devices.

583 VI. CONCLUSION

584 In conclusion, we have developed a low-cost energy-
 585 efficient 3D nano-spike based electric cell lysis (NSP-ECL)
 586 chips for efficient cell lysis at low pulse amplitudes and
 587 duration. Highly-ordered self-aligned 3D Al NSP arrays with
 588 controllable dimensions, i.e., length, L_{ns} , base radius, R_{ns} ,
 589 and pitch, P_{ns} (spike to spike distance) were fabricated
 590 on low-cost commercial Al foils through simple, scalable,
 591 reproducible and cost effective electrochemical anodization
 592 and etching processes. The electric field has been localized
 593 at NSPs due to optimized aspect-ratio with an enhancement
 594 factor α as compared to micro-distant parallel plate electric
 595 cell lysis (μ PPECL) chips without NSPs. NSP-ECL chips
 596 have achieved high cell lysis efficiencies η_{lysis} (100%) at
 597 more than ten times reduced pulse amplitudes (2 V) through
 598 localized electric field E_{ns} as compared to the μ PPECL
 599 chips without NSPs. These applied pulse amplitudes are
 600 2-3 times reduced as compared to traditional electropora-
 601 tion systems used for different applications. The specific
 602 energy input required to achieve 100% η_{lysis} was only in
 603 the range of 0.5-2 mJ/mL which is 3-9 orders of magni-
 604 tude lower as compared to other cell disintegration methods
 605 (5J/mL-540kJ/mL). The employment of NSPs fabricated
 606 through low-cost EA&E process, optimized AC electric pulses
 607 with low amplitudes and short durations minimized undesir-
 608 able electrochemical reactions, such as gas and bubble genera-
 609 tion on NSP-ECL chips which were observed on micro devices
 610 due to high voltage operation. Due to the scalability of the
 611 fabrication process, 3D NSPs were fabricated on small chips as
 612 well as on wafers to process samples for microsystems as well
 613 as for high throughput applications. These energy-efficient
 614 NSP-ECL chips are highly attractive for integration with
 615 other sample preparation downstream processes on portable
 616 LOC and μ -TAS systems due to its low power consumption,

reliability, cost-effectiveness and avoiding micronization of
 cell debris. Based on these low voltage devices, we can
 add additional ECL tool in a recently developed “Lab on
 Smartphone” through which optimized EP protocols can be
 applied to micro/nano EP chips through an open-source MCU
 (Arduino) with an integrated Bluetooth module [48].

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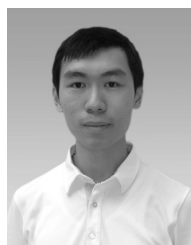
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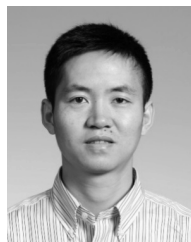
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IEEE PROOF

Low-Cost Energy-Efficient 3-D Nano-Spikes-Based Electric Cell Lysis Chips

Kashif Riaz, Siu-Fung Leung, Zhiyong Fan, *Member, IEEE*, and Yi-Kuen Lee, *Member, IEEE*

Abstract—Electric cell lysis (ECL) is a promising technique to be integrated with portable lab-on-a-chip without lysing agent due to its simplicity and fast processing. ECL is usually limited by the requirements of high power/voltage and costly fabrication. In this paper, we present low-cost 3-D nano-spikes-based ECL (NSP-ECL) chips for efficient cell lysis at low power consumption. Highly ordered HAR NSP arrays with controllable dimensions were fabricated on commercial aluminum foils through scalable and electrochemical anodization and etching. The optimized multiple pulse protocols with minimized undesirable electrochemical reactions (gas and bubble generation), common on micro parallel-plate ECL chips. Due to the scalability of fabrication process, 3-D NSPs were fabricated on small chips as well as on 4-in wafers. Phase diagram was constructed by defining critical electric field to induce cell lysis and for cell lysis saturation E_{sat} to define non-ECL and ECL regions for different pulse parameters. NSP-ECL chips have achieved excellent cell lysis efficiencies η_{lysis} (ca 100%) at low applied voltages (2 V), 2~3 orders of magnitude lower than that of conventional systems. The energy consumption of NSP-ECL chips was 0.5-2 mJ/mL, 3~9 orders of magnitude lower as compared with the other methods (5J/mL-540kJ/mL). [2016-0305]

Index Terms—Nano-spikes, electric cell lysis chips, electrochemical anodization and etching processes, electric field enhancement, energy-efficient, lab on chip.

I. INTRODUCTION

CELL LYSIS is an important step in sample preparation procedures and biopharmaceutical product extraction to release intracellular contents, i.e., DNA, RNA, hormones, vaccines, antibodies, recombinant proteins, and so forth. by disrupting cell membrane [1]–[6]. Economics of these procedures is greatly influenced by downstream processing steps, i.e., separation, purification, and so on. [1]. Sample preparation for molecular, protein and genomic diagnostic and analysis is time-consuming, labor intensive and costly process due

to multiple steps and bulky instruments [4], [6]–[8]. Lab-on-a-chip (LOC) and micro total analysis system (μ -TAS) are rapidly growing in different fields ranging from molecular/protein/genome diagnostic and analysis to the search for life on Mars [9]–[13]. Due to recent developments in micro/nanotechnologies, conventional bulky and costly sample preparation processes can be scaled down and integrated into a single compact, automated, and portable microsystem, LOC or μ -TAS [4]–[12]. These microsystems have great promise due to their simplicity, low cost, time efficiency, low consumption of valuable reagents and biological samples [4]–[12].

Numerous techniques have been employed for cell lysis on integrated microsystems, LOC, or μ -TAS such as mechanical, chemical, thermal, ultrasonic, optical, electrical, with their unique advantages and limitations [2]–[7]. Mechanical cell lysis (MCL) based on exerting localized high pressure, shear stress, friction forces, compressive stress, on cell membrane through micro-channels, filters, moving membranes, beads, etc [2]–[5]. MCL integration on LOC is limited due to moving parts and blockage of micro/nanochannels, gaps, filters by cell debris [3]–[5]. Furthermore, due to cell debris micronization into small fragments and non-selective release of products through MCL; additional costly and time-consuming separation and purification steps are required [3]–[5]. Chemical cell lysis (CCL) utilized lysis agents such as surfactants, enzymes, detergents, etc., to dissolve cell membrane in microfluidic channel network [2]–[5]. CCL methods are limited due to pretreatment of lysing agents, purification of the added agents for downstream processing, different protocols for different samples and inherently slow due to complex chemical processes [3]–[5]. Thermal cell lysis utilized high temperatures and cyclic heating for cell lysis but not suitable for portable LOC systems due to high power requirement for heat generation and irreversible protein denaturation [3]–[5]. Ultrasonic cell lysis is not suitable for LOC systems due to complex instrumentation, excessive heat generation, and inefficient power transmission to samples [2]–[5]. Intracellular product yield greatly improved by increasing the intensity of cell lysis methods mentioned above, but it also increases micronization of cell debris and additional contaminants from intracellular compartments [1]. This increases the production cost and processing time due to additional downstream processing, i.e., separation, purification, etc. [1].

Electric Cell lysis (ECL) is a physical method that has potential to overcome these limitations due to its simplicity, cost effectiveness, high efficiency, fast processing, easy miniaturization, applicability to diverse samples, and possible

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TABLE I
COMPARISON OF MICRO/NANO ELECTRIC CELL LYSIS CHIPS

Ref.	Electrode	Amplitude (V)	Duration	Efficiency (%)	Remarks
[39]	3D Au/Ti micro	~8.5	-	74	Low efficiency
[40]	Pt/Ti micro	10-40	-	<80	Bubble generation
[18]	3D Au/Cr micro	10	-	30	Low efficiency
[38]	MWCNT	40	-	~100	High voltage
[14]	Cr/Au micro	20	100 μ s	90	High voltage
[41]	Cr/Au micro	10	-	80	Low efficiency
[42]	Cr/Au micro	10	-	80	Low efficiency
[43]	ITO micro	30	-	61	Low efficiency
[44]	Cr/Au micro	5-6	5-10 min.	>95	Longer time
[45]	3D carbon micro	130	400 ms	90	High voltage
[46]	Pt/Ta micro	20	0.5-2 s	~100	High voltage
Our work	3D Nano spikes	2	12ms	100\pm0.1	Low voltage High efficiency

TABLE II
COMPARISON OF ELECTRIC CELL LYSIS ON ELECTRODES WITH AND WITHOUT NANOSTRUCTURES

Ref.	Nano-structures	Voltage requirement (V)	Without nano-structures (V)	Efficiency (%)
[38]	MWCNTs	40	85	100
[35]	CNTs	35	135	>95
[36]	CNTs	35	135	>95
[37]	CNTs	40	>90	100
[34]	Nano-gaped ITO electrodes	9	-	~90
this paper	3D Nano-spikes	2	>10	100 \pm 0.1

integration with downstream processes as no lysis agents required [2]–[6], [14]. ECL employs intense pulsed electric field to induce irreversible nanopores on cell membrane which leads to cell lysis [2], [3]. ECL has been proved effective in avoiding complete cell disruption, micronization of cell debris and contaminants from intracellular compartments by selectively lysing the cell membrane rapidly and quickly [15]. Besides these advantages, ECL methods are limited by high energy consumption (5-500 J/mL) and voltage requirement (few tens of volts) as listed in Table 1 to achieve critical electric field for cell lysis E_{CL} (kV/cm). To fulfill these requirements, special costly and bulky power generators are necessary. This is highly undesirable in portable LOC applications [3], [4], [16]. Various designs have been proposed to achieve E_{CL} at low voltages either by decreasing the distance between electrodes or focusing electric field through small constriction segments and structures in microchannels or micro-chambers [2]–[4], [17]. Most commonly used 2D planar electrodes suffer from uneven exposure of cells to an electric field, resulting in low cell lysis efficiencies η_{lysis} [3], [16]. 3D electrodes were designed to overcome this drawback which showed higher η_{lysis} (30%) as compared to 2D electrodes (8%) [18]. However, the fabrication of 3D electrodes usually involves complex, time-consuming and costly fabrication steps [19], [20].

Direct current (DC) voltage is preferred as cell membrane experienced larger transmembrane potential (TMP) without lysing the intracellular components [3], [4], [17]. However, the voltage required to achieve electric field in kV/cm range usually lead to water electrolysis which may lead to gas bubble generation, extreme pH conditions and Joule

heating [3], [21]. Alternating current (AC) voltages have been used to minimize these problems for on-chip ECL at optimized frequencies [3], [4], [21]. Depending on applied electric pulse amplitude, duration and number (usually high for ECL), AC ECL techniques also suffer from gas bubble generation, Joule heating, and pH variations [21]–[24]. These undesirable phenomena resulted in the production of unwanted electrolytic chemical compounds led to electrode degradation, effects on thermo-sensitive intracellular contents, i.e., proteins and on reaction kinetics of specific application [25]–[27]. To avoid these drawbacks, subcellular sized constriction structures were employed in a microchannel, so that maximum potential drop was across the cell membrane trapped in these structures instead of in the vicinity of the electrodes [28], [29]. The integration of these structures on portable LOC is limited by complex and costly manufacturing steps, expensive equipment for micro/nanoflow, channel blocking by cell debris and bubbles [3], [17], [25]–[27]. The average electric current between the electrodes can also be reduced by applying AC pulses with low amplitude and shorter duration. However, pulse parameters should be optimized to achieve high η_{lysis} in addition to the minimization of undesirable electrochemical reactions [21], [25], [30], [31]. Cell lysis efficiencies were always a concern in previous reports and η_{lysis} were well below 100% in most of the methods mentioned above [2], [3], [4] (Table 1).

High-aspect-ratio nano-structures (nano-tubes, nano-wires etc.) were incorporated on electrodes to locally enhance electric field intensity to cell membranes and used for cell lysis [32]–[37]. The cell lysing results on these chips indicated that required voltage reduced as compared to electrodes without nano-structures but still in the range of few tens of volts [32]–[37] (Table 2). One of the bottlenecks in the integration of nanostructures on microchips are the difficulties in handling, aligning and positioning the nanostructures at the exact desired location [46]. Furthermore, the fabrication techniques employed are complex, costly, time-consuming and non-reproducible [46]. It is highly desirable to establish simple, inexpensive, reliable and scalable fabrication techniques for fabrication of reproducible and aligned nanostructures to be used in integrated portable LOC systems and potential mass production [9], [46]–[48].

In this work, we present a low-cost 3D nano-spike based electric cell lysis chip which employed self-aligned highly

158 ordered 3D Aluminum (Al) nano-spike (NSP) arrays fabricated
 159 through electrochemical anodization and etching (EA&E)
 160 processes using anodic alumina membrane(AAM) as a tem-
 161 plate. 3D self-aligned highly ordered nano-structures were
 162 fabricated using EA&E processes recently due to their sim-
 163 plicity, low cost, reproducibility, and scalability [49]. These
 164 nano-structures showed enhanced performance in the field of
 165 electronics, optoelectronic, photovoltaic, magnetism, medical,
 166 and biology [49], [51]–[54]. Alumina is already recognized
 167 as bio-compatible material and used in hip arthroplasty [55],
 168 tissue engineering especially for skin replacement [56], bone
 169 implant [57], and cell culture and proliferation [58].

170 We developed an energy-efficient 3D nano-spikes based
 171 electric cell lysis (NSP-ECL) chips for efficient cell lysis
 172 at low energy consumption. NSP-ECL chips comprised of
 173 highly-ordered high-aspect-ratio (λ) 3D Al NSP arrays with
 174 controllable dimensions, i.e., length, L_{ns} , base radius, R_{ns} ,
 175 and pitch, P_{ns} (spike to spike distance). These optimized
 176 aspect-ratio λ ($= L_{ns}/R_{ns}$) NSPs were fabricated on low-cost
 177 commercial Al foils through simple, scalable, reproducible
 178 and cost effective EA&E process. The electric field has been
 179 localized at NSPs due to high λ with an enhancement factor
 180 α . NSP-ECL chips have achieved high cell lysis efficiencies
 181 η_{lysis} (100%) at more than ten times reduced pulse ampli-
 182 tudes (2 V) through localized electric field E_{NSP} as compared
 183 to micron-distant parallel plate electric cell lysis (μ PPECL)
 184 chips without NSPs. The employment of low-cost EA&E
 185 fabrication process, optimized AC electric pulses with low
 186 amplitudes (2 V), short durations (few milliseconds) and low
 187 energy consumption (0.5-2 mJ/mL) minimized undesirable
 188 electrochemical reactions, such as gas and bubble generation
 189 on NSP-ECL chips. Due to the scalability of the fabrication
 190 process, 3D NSPs were fabricated on small chips as well as
 191 on wafers.

192 II. NANO-SPIKES BASED ELECTRIC CELL LYSIS SYSTEM

193 Schematic diagram of a nano-spikes based electric cell
 194 lysis (NSP-ECL) system along with optical micrograph
 195 of fabricated nano-spikes on an Al foil and packaged
 196 NSP-ECL chip is shown Fig. 1. NSP-ECL chips consist
 197 of 3D periodic NSP arrays fabricated on a low-cost commer-
 198 cial Al foil using nano-imprint lithography, electrochemical
 199 processes, i.e., anodization and etching and MEMS technol-
 200 ogy. By controlling dimensions of NSPs, NSPs were fab-
 201 ricated with different aspect ratios λ ($= L_{ns}/R_{ns}$). Large
 202 λ resulted in electric field enhancement E_{ns} at NSPs and
 203 applied electric field E_a was enhanced with an enhancement
 204 factor α . A PCI 6110 DAQ card (National Instrument, TX,
 205 USA) and a Labview program were used to apply AC electric
 206 pulses with adjustable pulse amplitudes V_a , durations t_p
 207 and number P_n to NSP-ECL chips. An Olympus IX70 inverted
 208 fluorescent microscope, and a QImaging Retiga 1300C digital
 209 CCD camera (Burnaby, B.C., Canada) were used to acquire
 210 a set of bright field and fluorescent micrographs before and
 211 after ECL through an image capture card. Cell lysis efficiency
 212 η_{lysis} were determined as functions of electric pulse param-
 213 eters (V_a , t_p and P_n) and NSPs dimensions using these acquired
 214 images through image processing. Due to E_{ns} and optimized

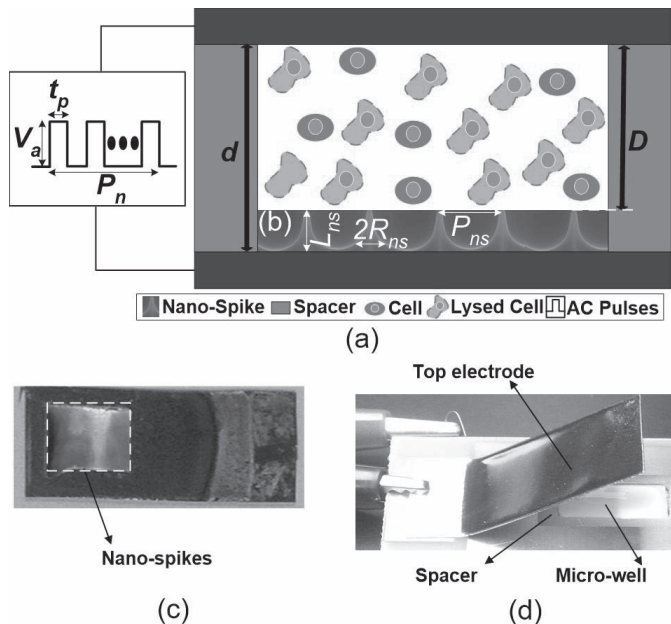


Fig. 1. Illustration of a Nano-Spikes Electric Cell Lysis (NSP-ECL) device, (a) the schematic diagram of an NSP-ECL chip with NSP arrays, (b) SEM micrograph of an array of nano-spikes, (c) optical micrograph of an Al foil with fabricated nano-spikes, and (d) optical micrograph of packaged NSP-ECL chip.

215 electric pulse parameters, NSP-ECL chips offer the advantage
 216 of achieving high η_{lysis} at reduced pulse amplitudes and
 217 shorter pulse durations. ECL with low pulse amplitudes and
 218 shorter pulse durations minimized undesirable electrochemical
 219 reactions such as gas and bubble generation and avoided com-
 220 plete disruption and micronization of cell membrane which is
 221 desirable in downstream process integration on LOC system.

222 A. Nano-Spikes Based Electric Cell Lysis Chip Design

223 3D periodic NSP arrays on a microchip were fabricated
 224 through electrochemical anodization and etching processes. 3D
 225 NSPs were fabricated with different controllable dimensions,
 226 such as length, L_{ns} , base radius, R_{ns} , and pitch, P_{ns} (spike to
 227 spike distance). The top and bottom electrodes are insulated
 228 by a spacer (3M Orange Polyimide electrical insulation tape)
 229 with a thickness d ($= 100\mu\text{m}$). The distance between the tip
 230 of the NSPs and the counter electrode of the NSP-ECL chip
 231 is defined as D ($= d - L_{ns}$). This spacer not only insulated
 232 two electrodes, but also formed a micro-well between two
 233 electrodes for cell sample and molecules injection (Fig. 1(a)).
 234 The incorporation of optimized aspect-ratio λ NSPs resulted
 235 in enhancement of applied electric field. The electric field
 236 at NSPs E_{ns} was enhanced by enhancement factor α which
 237 depends on the aspect ratio of NSPs. The top electrode of
 238 NSP-ECL chip is removable, and cell lysate can be collected
 239 from micro-well after electric cell lysis using a pipette.

240 B. 3D Nano-Spikes Fabrication Process

241 Major steps involved in the fabrication of NSP-ECL
 242 chips were nano-imprinting and scalable electrochemical
 243 anodization and etching processes [31], [51]–[54], [59]. First
 244 of all, low-cost commercially available *ca* 250 μm thick

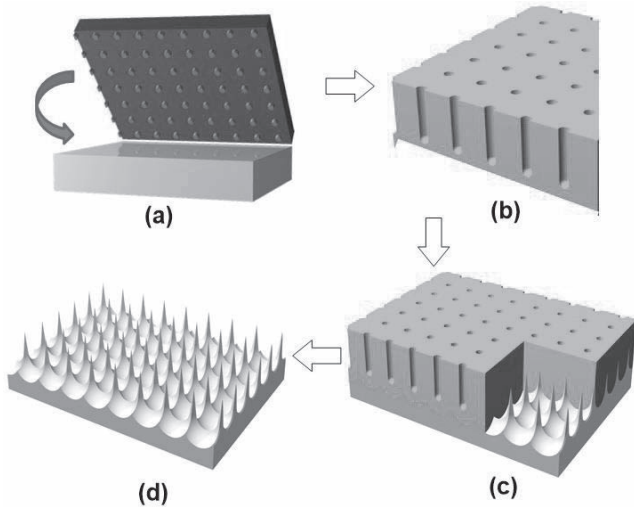


Fig. 2. Key fabrication processes of low-cost highly-ordered 3D nano-spike arrays using electrochemical anodization and etching processes, (a) Al foil was imprinted by a silicon mold with square patterned pillars, (b) imprinted Al foil with periodic nanoholes, (c) imprinted substrate was anodized and then etched to fabricate 3D nano-spike arrays, and (d) 3D high aspect-ratio nano-spike arrays fabricated through electrochemical anodization and etching processes.

Al foils (99.99% Alfa Aesar, MA, USA) were cut into pieces of $2 \times 1 \text{ cm}^2$. These Al substrates were cleaned with acetone and then rinsed with isopropyl alcohol and deionized (DI) water. These cleaned substrates were electrochemically polished for 4 minutes at 5°C in a 1:3 (v:v) mixture of perchloric acid and ethanol. A silicon stamp with square patterned pillars with a height of $\sim 200 \text{ nm}$, the diameter of $\sim 200\text{-}500 \text{ nm}$ and pitch of $1.2 \mu\text{m}$ was used for nano-imprinting (Fig. 2(a)). The electropolished substrates were imprinted by the stamp and substrates had perfect square ordered nano-indentation which defined the location of the anodic alumina membrane (AAM) pores (Fig. 2(b)). The imprinted substrates were then anodized in a home-built anodization setup using carbon rod as counter electrode using DC voltage of 600 V. The composition of electrolyte used for anodization was 1:1 (v:v) 2wt% Citric acid: Ethylene Glycol + 9 mL 0.1wt% Phosphoric acid. NSPs with different aspect ratios were fabricated by controlling anodization conditions, i.e., anodization time varies between 30-360 minutes at 10°C . Stability of electrolyte was improved by mixing citric acid with ethylene glycol, and the anodization voltage was increased up to 600 V [51]–[54]. The mixture of phosphoric acid (6%) and chromic acid (1.5%) was used to etch the anodized AAM layer at 100°C for 25 minutes to obtain perfectly ordered 3D NSP arrays (Fig. 2(c)). After etching, the 3D Al NSP electrodes were rinsed with DI water and blown dry with compressed air.

C. Scalability of Nano-Spikes Fabrication Process

The dimensions of NSPs were precisely controlled by controlling the parameters and conditions of EA&E process, i.e., the thickness of AAM, anodization time, etc. NSPs with different lengths L_{ns} ranging from 350-1100 nm was fabricated by increasing anodization time from 30-360 minutes. The maximum achievable L_{ns} was about $\sim 1100 \text{ nm}$ after

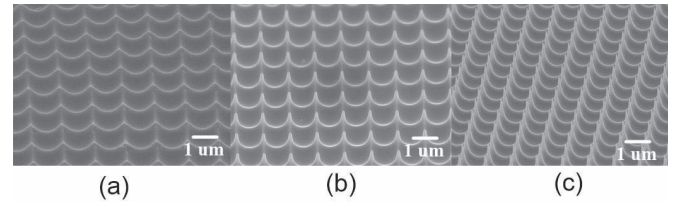


Fig. 3. SEM micrograph of 3D nano-spike arrays with different lengths L_{ns} of (a) 350 nm, (b) 750 nm, and (c) 1100 nm.

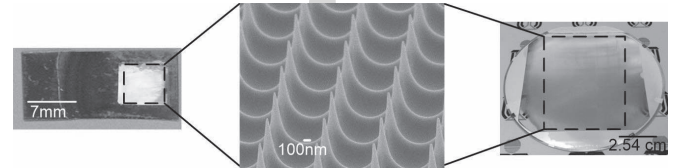


Fig. 4. Highly-ordered 3D nano-spike arrays fabricated on low-cost commercial Aluminum foil with an area of 7mm^2 and also on a 4-inch glass wafer.

anodization of 360 minutes. SEM images of NSP array electrodes with L_{ns} of 350, 750, and 1100 nm with pitch P_{ns} of $1.2 \mu\text{m}$ are shown in Fig. 3. Several advantages are associated with NSPs fabricated using EA&E processes such as periodicity, self-organization, scalability, reproducibility, and high-aspect-ratio λ . Due to the scalability of above mentioned EA&E fabrication process, it was possible to fabricate NSPs on low-cost Al foils for microchips as well as on 4-inch glass wafers (Fig. 4). The sample in microliter range was processed on 3D NSP-ECL chips, while throughput can be scaled up to handle large cell populations ($10^4 - 10^5$) on NSP-ECL wafers. This simple, low-cost, scalable, reproducible and reliable process is highly attractive for low energy and cost-effective portable μ -TAS, LOC and smartphone-based systems as well as for high throughput and large population applications.

III. MATERIAL AND METHODS

A. Cell Line Preparations

Human cervical cancer (HeLa) cell line was used in the ECL experiments to characterize cell lysis efficiencies η_{lysis} on NSP-ECL chips. HeLa cells were cultured and grown in Eagle's minimal essential medium (EMEM) (CCL-2TM, ATCC, VA, USA), supplemented with 10% fetal bovine serum (FBS) (ATCC, VA, USA) and 1% Streptomycin/Penicillin (GIBCO®, Invitrogen Inc., USA) at 37°C and 5% CO_2 . To perform the ECL experiments on the NSP-ECL chips, HeLa cells were re-suspended in the Phosphate buffered saline (PBS). Then, the EMEM medium was sucked, washed twice with PBS and trypsinized by 0.25% trypsin/EDTA (GIBCO®, Invitrogen Inc., USA) for 3-5 minutes at 37°C . The detached cells were centrifuged at 1,200 rpm at room temperature for 3 minutes. The concentration of HeLa cells was adjusted to $1 \times 10^5 \text{ cells/mL}$ in suspension.

B. Dual Acridine Orange/Ethidium Bromide Fluorescent Staining

Cell lysis efficiencies η_{lysis} is defined as the percentage of dead cells after application of a lysing electric field [44].

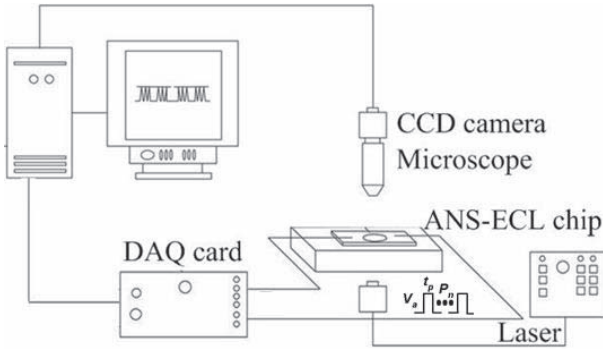


Fig. 5. The schematics of the experimental setup to perform the electric cell lysing on the fabricated NSP-ECL chips.

η_{lysis} can be determined by using dual fluorescent dye staining using Acridine Orange and Ethidium Bromide (AO/EB; Sigma, St Louis, MO, USA) which are nuclear staining dyes [60]–[62]. Acridine Orange (AO) is a membrane permeable dye and emits green fluorescence while Ethidium Bromide (EB) is membrane-impermeable dye and emits red fluorescence after entering the cell through compromised membranes. Upon staining cells with dual AO/EB dyes, live cells emit green fluorescence while lysed cells with damaged membrane emit orange-yellow fluorescence [60]–[62]. To determine η_{lysis} , the cell suspension was injected to the NSP-ECL chips and the electric pulses were applied. False readings from the reversibly electroporated cells were avoided by adding dual AO/EB staining solution to the cell suspension 5 minutes after the application of electric pulses on the NSP-ECL chips. Lysed cells exhibited orange-yellow fluorescence when EB dye bind with DNA/RNA either inside or outside the cell through the ruptured cell membrane. η_{lysis} was calculated by counting cells that appeared orange-yellow under fluorescence over the entire cells.

C. Experimental Setup

A PCI 6110 DAQ card (National Instrument, TX, USA) and a Labview program were used to apply electric pulses with adjustable pulse amplitude (V_a), pulse duration (t_p) and pulse number (P_n) to the NSP-ECL chip as shown in Fig. 5. The cell's response before and after ECL was observed using an Olympus IX70 inverted fluorescent microscope and a QImaging Retiga 1300C digital CCD camera (Burnaby, B.C., Canada) (Fig. 5). Sets of bright field and fluorescence micrographs were acquired by an image capture card. These digital images were processed to determine the η_{lysis} as a function of electric pulse parameters on NSP-ECL chips.

D. Statistical Analysis

At least 100 cells were analyzed to obtain each data point, and each experiment was repeated at least three times. The standard deviation between repeated experiments was shown as error bars.

IV. ELECTRIC FIELD ENHANCEMENT

Electric field distribution was simulated to evaluate the electric field enhancement at NSPs. A commercial finite

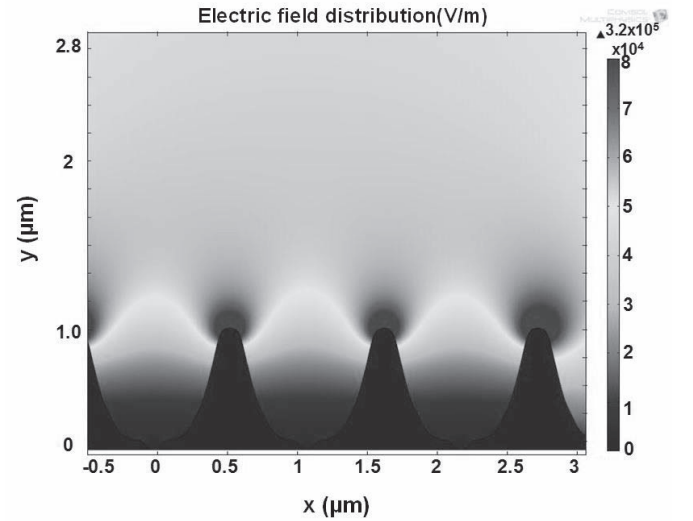


Fig. 6. Numerical simulation of the electric field distribution between nano-spike array electrodes using COMSOL at $V_a = 4V$. The simulation shows local electric field enhancement, especially near the nano-spikes.

element method (FEM) package (COMSOL Multiphysics 4.2, COMSOL Ltd., USA) was used for electric field distribution simulations [63]. The profile of NSPs was extracted with the help of extract profiles tool using the AFM images of NSPs. The extracted coordinates of NSPs were then exported to COMSOL. The cell lysis chamber is *ca* 100 μm high (the distance between the top and bottom electrode). The top electrode and the tip of the spikes on the bottom electrode were separated by a distance D (99 μm) and the space between the two electrodes was considered as cell suspension medium (Fig. 6). The relative permittivity and conductivity of cell suspension medium were assumed to be $77.4 \pm 5\%$ and $1.7 S/m \pm 10\%$, respectively [59]. The fixed potential between the electrodes was used as the boundary condition. The fixed potential between the electrodes was applied by selecting 2D stationary electrostatics physics in COMSOL. These simulations demonstrated that applied electric field E_a is enhanced and defined by enhancement factor α which on the other hand highly depend on the aspect ratio λ of NSPs. The enhanced electric field E_{ns} is very large near tips of NSPs and E_{ns} become uniform few nm above 3D NSP arrays as shown in Fig. 6.

The enhanced electric field E_{ns} was localized on NSPs due to the optimized aspect ratio λ of NSPs. The enhancement factor α by which the applied electric field E_a is enhanced can be estimated using the following relation [64], [65]:

$$E_{ns} = E_a \times \alpha \times \gamma \quad (1)$$

where E_a is the applied electric field (V_a/D), α is the enhancement factor and γ is the correction factor to incorporate the electrochemical impedance near the fluid-electrode interface and determined through electrochemical impedance spectroscopy [66], [67]. Based on the geometries of nanostructures, several models have been proposed to estimate α [65]. In our case, the α was estimated by considering NSP as a hemi-ellipsoid with length L_{ns} and base radius R_{ns} as

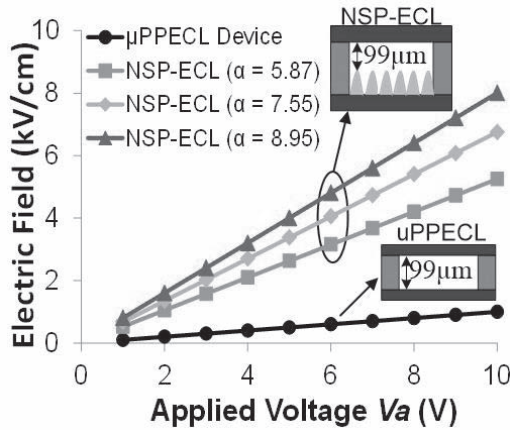


Fig. 7. Electric field as a function of applied voltages V_a for micro parallel plate electric cell lysing (μ PPECL) device without nano-spikes and NSP-ECL devices with different α .

follows [65]:

$$\alpha = \zeta^3 / [\{\lambda \ln(\lambda + \zeta)\} - \zeta] \quad (2)$$

where $\zeta = (\lambda^2 - 1)^{1/2}$ and λ is the aspect ratio of NSP (L_{ns}/R_{ns}). It is evident from (2) that α is a function of λ and α can increase exponentially with increasing λ . As mentioned previously, the aspect ratio λ can be controlled by controlling dimensions of NSPs. We have successfully fabricated NSPs with λ up to 3 using EA&E process. For NSPs with L_{ns} of 1100nm, the R_{ns} was 375nm which leads to the aspect ratio of around 3. For NSPs with λ ranging between 2 and 3, α was estimated between 5.9 and 8.9 using Equation (2). For micron-distant parallel plate electric cell lysing (μ PPECL) devices without NSPs, the electric field E_{planar} can be estimated as the ratio of applied voltage V_a to the distance between parallel plate electrodes D ($E_{planar} = V_a/D$). Interelectrode distance D of $\sim 99 \mu\text{m}$ was considered for both μ PPECL and NSP-ECL devices to compare electric field. Enhanced electric field at NSPs E_{ns} was determined using (1) and (2). The electric field was enhanced at NSP-ECL devices by enhancement factor α as compare to μ PPECL devices (Fig. 7). This means that lower voltages are required to achieve a specific electric field on the NSP-ECL devices depending on α as compared to μ PPECL devices. For example, electric field of 2 kV/cm can be achieved at 20 V for μ PPECL device, at ~ 4 V for NSP-ECL device with α of 5.87, at ~ 3 V for NSP-ECL device with α of 7.55 and at ~ 2.6 V for the NSP-ECL device with α of 8.95 (Fig. 7).

V. RESULTS AND DISCUSSION

When a cell is exposed to an externally applied electric field, localized transient microstructural changes and nanopore generation takes place in the cell membrane. These changes and induced nano-pores can either reseal (reversible electroporation) or non-reseal (irreversible electroporation) depending on applied electric pulse parameters V_a , t_p and P_n [34]–[37]. Irreversible electroporation causes rupturing of the cell membrane and cell lysis due to dielectric breakdown of the cell membrane as cell unable to maintain essential

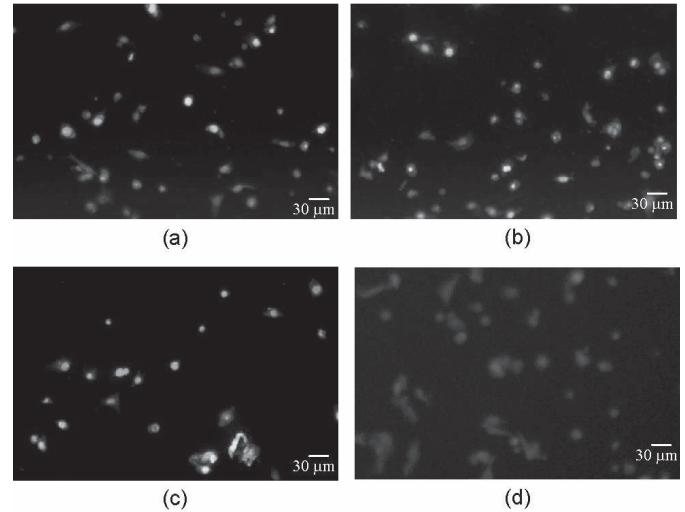


Fig. 8. Fluorescence micrographs of Acridine orange and Ethidium bromide dual stained HeLa cells treated on NSP-ECL chips and μ PPECL devices. Viable cells exhibit green fluorescence while lysed cells exhibit orange-red fluorescence due to loss of membrane integrity. (a) HeLa cells undergone electric cell lysis (ECL) on μ PPECL without nano-spikes at pulse amplitude $V_a = 5\text{V}$ and pulse duration $t_p = 12\text{ms}$, (b) HeLa cells before ECL on NSP-ECL chips ($\alpha = 8.9$), (c) HeLa cells after ECL on NSP-ECL chips ($\alpha = 8.9$) at $V_a = 2\text{V}$ and $t_p = 10\text{ms}$, and (d) HeLa cells after ECL on NSP-ECL chips ($\alpha = 8.9$) at $V_a = 2\text{V}$ and $t_p = 12\text{ms}$.

ionic balance across the membrane. ECL occurs only when applied electric pulse parameters V_a , t_p and P_n are well above their critical values [4]. Irreversible nano-pore generation is initiated when an electric field is well above its critical value E_{CL} which in turn determined by pulse amplitude V_a and density and duration of these nanopores depend on t_p and P_n [34]–[37]. It is critical to optimize these electric pulse parameters to achieve high η_{lysis} at low energy consumption to avoid undesirable electrochemical reactions and possible integration with portable devices. In our ECL experiments, we have applied rectangular AC pulses with adjustable V_a of 1–10 V, t_p of 1–12 ms and P_n of 1-10 on NSP-ECL chips with α of 5.87, 7.55 and 8.95.

A. Fluorescence Microscopy

Cell lysis efficiencies were quantified by using dual AO/EB fluorescent staining (Fig. 8). Fluorescence micrographs of cells before ECL on NSP-ECL chips showed no yellow-orange fluorescence as cell membrane was intact and impermeable to EB dye molecules (Fig. 8(b)). After ECL, cell membrane ruptured due to induction of irreversible nanopores on cell membranes by applied electric field. EB molecules entered the cells through compromised membrane and stained the lysed cells. Lysed cells exhibited orange-red fluorescence, while the live cells emitted green fluorescence (Fig. 8(c) & (d)). Almost all cells exhibited orange-red fluorescence when lysed on NSP-ECL chips at 2 V and 12 ms pulses showing high η_{lysis} . Fluorescence micrograph of ECL on μ PPECL devices at 5 V and 12 ms pulses showed almost no orange-red fluorescence showing very low η_{lysis} (Fig. 8(a)).

B. Enhancement Factor Effect on Electric Cell Lysis

Cell lysis efficiencies were quantified on NSP-ECL chips with different α and on μ PPECL devices in order to determine

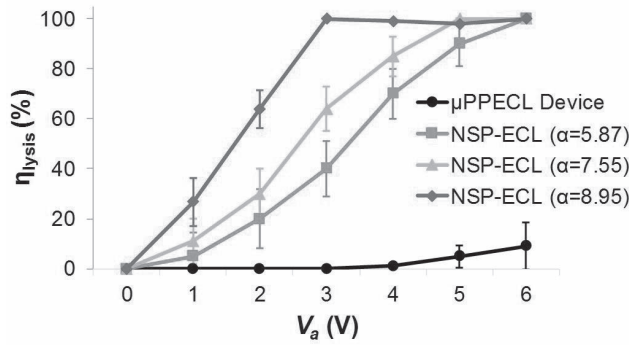


Fig. 9. Cell lysis efficiency η_{lysis} as a function of applied pulse amplitude V_a on NSP-ECL chips with different α (5.9, 7.5, 8.9) and the cell lysis efficiency of the μ PPECL device for pulse duration t_p of 10ms.

459 the effect of α on η_{lysis} as compared to μ PPECL devices
 460 without NSPs. From Fig. 9, it is clear that cell lysis on
 461 NSP-ECL chips showed higher η_{lysis} as compared to cell lysis
 462 on μ PPECL devices at specific V_a due to enhanced electric
 463 field E_{ns} on NSPs. At $V_a = 3$ V, the η_{lysis} was 40 to 100%
 464 high on NSP-ECL chips as compared to μ PPECL devices
 465 depending on enhancement factor α of NSP-ECL chips.
 466 η_{lysis} was increased with increasing α on NSP-ECL chips at
 467 specific V_a . η_{lysis} of 40%, 64% and 100% were achieved at
 468 $V_a = 3$ V on NSP-ECL chips with α of 5.87, 7.55 and 8.95
 469 respectively. NSP-ECL chips with α of 8.95 was selected for
 470 further analysis due to high η_{lysis} at low voltages.

471 C. Critical Values for Electric Cell Lysis

472 Based on the applied electric field, ECL process can be
 473 divided into three phases as shown in Fig. 10. When the
 474 applied electric field is below critical electric field E_{CL} , η_{lysis}
 475 is very low as the electric field is not sufficient to induce
 476 enough irreversible nano-pores rather reversible nanopores on
 477 the cell membrane. When the applied electric field was above
 478 E_{CL} , the electric field was strong enough to break down the
 479 integrity of cell membrane by inducing enough irreversible
 480 nano-pores. EB fluorescent molecules bound to DNA/RNA
 481 inside or outside the ruptured cell membrane and lysed cells
 482 exhibited orange-red fluorescence (Fig. 8(c) and (d)). At this
 483 stage, a small increase in pulse amplitude V_a , more and more
 484 cells lysed and η_{lysis} increased quickly (Fig. 10). η_{lysis} keep on
 485 increasing by increasing electric field until η_{lysis} saturated and
 486 electric field at this point defined as saturation electric field
 487 E_{sat} (Fig. 10). Further increase in V_a did not improve η_{lysis}
 488 but increased power consumption.

489 D. Electric Pulse Parameters Effects on Electric Cell Lysis

490 The cell lysis efficiencies were greatly influenced by applied
 491 electric pulse parameters such as V_a , t_p and P_n . Higher η_{lysis}
 492 can be achieved at higher pulse amplitude V_a , longer pulse
 493 duration t_p and higher pulse number P_n (Fig. 10). Higher pulse
 494 amplitude V_a and longer pulse duration t_p increased power
 495 requirement and may also induce undesirable electrochemical
 496 reactions. Electric pulse parameters should be optimized to
 497 achieve high η_{lysis} but at lower V_a and shorter t_p to minimize

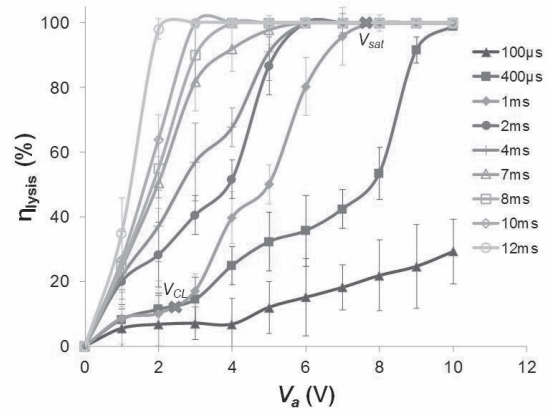


Fig. 10. Cell lysis efficiency η_{lysis} as a function of V_a and t_p for P_n of 10 on NSP-ECL chip.

498 electrochemical reactions and power requirement. We have
 499 reached high η_{lysis} ($\sim 100\%$) at V_a of 2 V, t_p of 12 ms and
 500 P_n of 10 on NSP-ECL chip (Fig. 10). This reduction in
 501 V_a is more than ten times lower as compared to μ PPECL
 502 devices.

503 E. Energy Requirement for Electric Cell Lysis

504 The energy consumption for electric cell lysis is a crucial
 505 issue especially in LOC, μ -TAS and smartphone based
 506 microsystems where limited energy is available [3], [68]. This
 507 energy requirement is high enough to employ complex, bulky
 508 and costly power generators and equipment [16], [69]. Due to
 509 high energy requirement, ECL systems usually undergo metal
 510 ion dissolution, local pH variation, Joule heating, gas and
 511 bubble generation and sample contamination [3], [4], [5], [17],
 512 [25], [68], [70]. In order to avoid these undesirable reactions
 513 on ECL devices and to integrate them on LOC, μ -TAS
 514 and smartphone based microsystems; low energy consumption
 515 ECL systems are highly desirable. In our approach, we utilized
 516 3D nano-spikes on which electric field was enhanced due to
 517 their optimized aspect-ratio. We were able to achieve cell lysis
 518 at lower pulse amplitudes due to electric field enhancement.
 519 The specific energy input W delivered to samples on NSP-
 520 ECL chips was calculated using relation:

$$521 \quad W = V_a I P_n t_p / vol \quad (3)$$

522 where V_a is the applied pulse amplitude, I is the electric
 523 current, P_n is the pulse number, t_p is the pulse duration, and
 524 vol is the sample volume (0.25 mL). A high-precision 1k Ω
 525 resistor was connected in series with the chip and serve as
 526 the current-to-voltage converter. The resistance of the resistor
 527 is too small as compared to the chip. Therefore, it can
 528 be ignored in the electric current calculation. The voltage
 529 signals from this resistor were measured by using a PCI 6110
 530 DAQ card (National Instrument, TX, USA) and a Labview
 531 program and used in the electric current calculation. The
 532 specific energy input W required to achieve optimized electric
 533 pulse protocol (2V \times 12ms for 10 pulses) was 0.5 mJ/mL
 534 (Fig. 11). The energy consumption for cell lysis on NSP-ECL

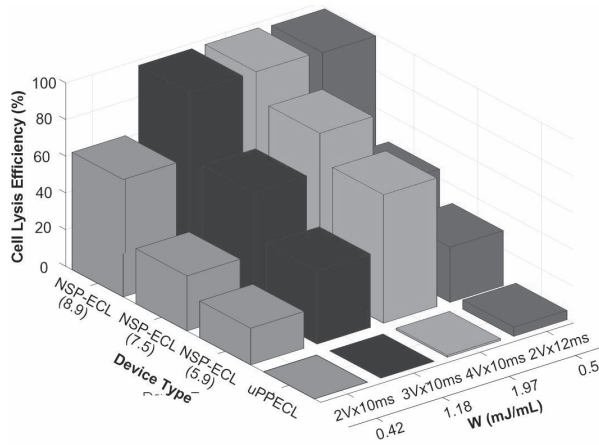


Fig. 11. η_{lysis} for different NSP-ECL and μ PPECL devices as a function of different electric pulse protocols and specific energy input W (mJ/mL).

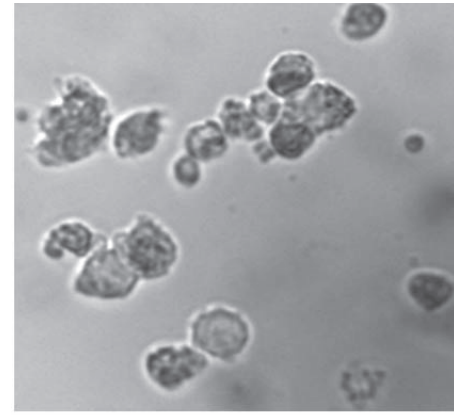
TABLE III
SPECIFIC ENERGY REQUIREMENT FOR CELL
LYSIS USING DIFFERENT METHODS

Ref.	Methods	Device characteristics	Treatment time	Specific energy input
[72]	Laser	Beam dia. of 100 μ m	60sec \times 10 times	16kJ/mL
[72]	Microwave	1025W 2.45GHz	20min.	74.6kJ/mL
[72]	Mechanical solid shear	Blade dia. 40mm 120W, 3000 rpm	6min.	540kJ/mL
[72]	Thermal lysis	90 $^{\circ}$ C	20min.	20.1 kJ/mL
[72]	Liquid shear ultrasonication	40W ultrasonic bath	20min.	132 kJ/mL
[73]	High voltage pulsed electric field	$L \times W = 30 \times 3 \text{mm}^2$ $d = 10 \text{mm}$	1 μ s	100-200 J/mL
[74]	Electroporation	$A = 0.78 \text{cm}^2$ $d = 0.3 \text{cm}$	μ s-ms	16-150 J/mL
[75]		$L \times W = 2.8 \times 0.6 \text{cm}^2$ $d = 1 \text{mm}$	100 μ s \times 32	5-533 J/mL
This paper	NSP-ECL device	NSP dimensions L : 350-1100nm D : 200-500nm	12ms \times 10	0.05-3 mJ/mL

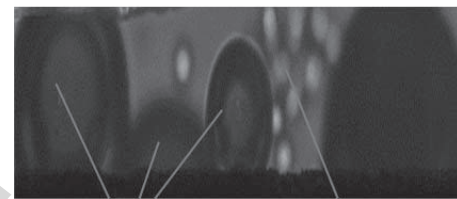
$L \times W$: electrode length \times width, d : interelectrode distance, A : electrode area, D : diameter

chips was 0.5-2 mJ/mL that is 3-9 orders of magnitude lower as compared to other cell disintegration methods as shown in Table 3.

Low device reliability and failure were observed in macro and micro ECL devices due to high voltage operations which resulted in electrolysis, gas bubble generation, Joule heating, local pH variations, etc. [21]–[27]. Electrode degradation and cell damage were observed during electroporation and ECL processes due to gas bubbles generation which resulted in local pH variations and violent hydrodynamic forces [21]–[24], [59]. Gas bubble generation was observed on micro devices due to high voltage operation especially above 6 V [22], [75] as shown in Fig. 12(b). Although AC pulses were applied on micro devices which were known to minimize electrochemical reactions, still applied pulse amplitudes were high



(a)



(b)

Fig. 12. Cell morphologies after electric cell lysis on (a) NSP-ECL chips, bubble generation, and cell micronization was avoided and (b) on a micro ECL chip, Bubble generation was observed on micro devices [22], [75].

enough to induce gas bubble generation and electrode degradation (Fig. 12 (b)). On the other hand, on NSP-ECL chips, due to the employment of NSPs, high η_{lysis} was achieved at low pulse amplitudes without bubble generation (Fig. 12(a)). In addition, the cell membrane was not fully disintegrated after ECL on NSP-ECL chips (Fig. 12(a)). This will avoid micronization of cell debris and complex, costly and time-consuming downstream processes.

F. Phase Diagram for Electric Cell Lysis

ECL occurs successfully when applied electric field is well above its critical value E_{CL} . It is crucial to determine electric pulse parameters to achieve E_{CL} as if the electric field is below this critical value; cells will be reversibly electroporated instead of lysed. E_{CL} was achieved at different V_a for different t_p , at lower V_a for longer t_p , and at higher V_a for shorter t_p . E_{CL} is defined as a critical electric field for cell lysis which induces irreversible nanopores on the cell membrane and η_{lysis} increases quickly. We have also determined electric pulse parameters to achieve saturation electric field E_{sat} at which η_{lysis} saturated. It is vital to determine E_{sat} as increasing pulse parameters after this point will only result in additional power hence energy consumption and micronization of cell debris which is not suitable for portable LOC systems and downstream processes. Using these parameters for E_{CL} and E_{sat} , we have constructed “phase diagram” for ECL of HeLa cells on NSP-ECL chips (Fig. 13). Phase diagram defines

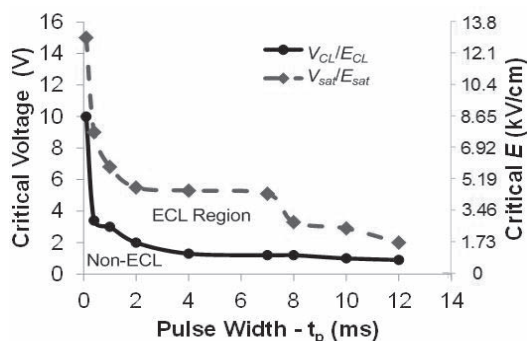


Fig. 13. The Phase diagram for the electric cell lysis of HeLa cells on the NSP-ECL chip ($\alpha = 8.9$). The Phase diagram shows the non-ECL and ECL regions for different applied pulse durations.

576 the boundary for non-ECL and ECL regions for different
 577 electric pulse parameters. Minimum pulse amplitude $V_{CL,min}$
 578 to achieve E_{CL} was 0.9 V for t_p of 12 ms which is more
 579 than thirteen times lower as compared to μ PPECL devices.
 580 Minimum pulse amplitude $V_{sat,min}$ to achieve E_{sat} was 2 V for
 581 t_p of 12 ms which is more than ten times lower as compared
 582 to μ PPECL devices.

583 VI. CONCLUSION

584 In conclusion, we have developed a low-cost energy-
 585 efficient 3D nano-spike based electric cell lysis (NSP-ECL)
 586 chips for efficient cell lysis at low pulse amplitudes and
 587 duration. Highly-ordered self-aligned 3D Al NSP arrays with
 588 controllable dimensions, i.e., length, L_{ns} , base radius, R_{ns} ,
 589 and pitch, P_{ns} (spike to spike distance) were fabricated
 590 on low-cost commercial Al foils through simple, scalable,
 591 reproducible and cost effective electrochemical anodization
 592 and etching processes. The electric field has been localized
 593 at NSPs due to optimized aspect-ratio with an enhancement
 594 factor α as compared to micro-distant parallel plate electric
 595 cell lysis (μ PPECL) chips without NSPs. NSP-ECL chips
 596 have achieved high cell lysis efficiencies η_{lysis} (100%) at
 597 more than ten times reduced pulse amplitudes (2 V) through
 598 localized electric field E_{ns} as compared to the μ PPECL
 599 chips without NSPs. These applied pulse amplitudes are
 600 2-3 times reduced as compared to traditional electropora-
 601 tion systems used for different applications. The specific
 602 energy input required to achieve 100% η_{lysis} was only in
 603 the range of 0.5-2 mJ/mL which is 3-9 orders of magni-
 604 tude lower as compared to other cell disintegration methods
 605 (5J/mL-540kJ/mL). The employment of NSPs fabricated
 606 through low-cost EA&E process, optimized AC electric pulses
 607 with low amplitudes and short durations minimized undesir-
 608 able electrochemical reactions, such as gas and bubble genera-
 609 tion on NSP-ECL chips which were observed on micro devices
 610 due to high voltage operation. Due to the scalability of the
 611 fabrication process, 3D NSPs were fabricated on small chips as
 612 well as on wafers to process samples for microsystems as well
 613 as for high throughput applications. These energy-efficient
 614 NSP-ECL chips are highly attractive for integration with
 615 other sample preparation downstream processes on portable
 616 LOC and μ -TAS systems due to its low power consumption,

reliability, cost-effectiveness and avoiding micronization of
 cell debris. Based on these low voltage devices, we can
 add additional ECL tool in a recently developed “Lab on
 Smartphone” through which optimized EP protocols can be
 applied to micro/nano EP chips through an open-source MCU
 (Arduino) with an integrated Bluetooth module [48].

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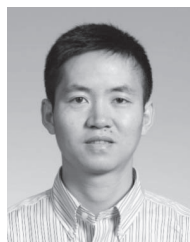
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